



US 20180061897A1

(19) **United States**(12) **Patent Application Publication**
OH et al.(10) **Pub. No.: US 2018/0061897 A1**(43) **Pub. Date: Mar. 1, 2018**(54) **ORGANIC LIGHT EMITTING DISPLAY
HAVING TOUCH SENSORS AND METHOD
OF FABRICATING THE SAME, AND
DISPLAY DEVICE**(52) **U.S. Cl.**
CPC **H01L 27/323** (2013.01); **H01L 2227/323**
(2013.01); **H01L 27/3279** (2013.01)(71) Applicant: **LG Display Co., Ltd.**, Seoul (KR)(57) **ABSTRACT**(72) Inventors: **Jae-Young OH**, Goyang-si (KR);
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LEE**, Goyang-si (KR); **Eun-Hye LEE**,
Paju-si (KR)(21) Appl. No.: **15/436,505**(22) Filed: **Feb. 17, 2017**(30) **Foreign Application Priority Data**

Aug. 31, 2016 (KR) 10-2016-0112192

Publication Classification(51) **Int. Cl.**
H01L 27/32 (2006.01)

Disclosed is a display device comprising: a substrate comprising an active region and a non-active region; a light emitting device that emits light in the active area of the substrate; a touch sensor in the active area of the substrate that senses touch of the display device, the touch sensor including a plurality of conductive layers arranged in a stacking sequence; and a plurality of routing lines in the non-active region of the substrate that are connected to the touch sensor, each of the plurality of routing lines including a plurality of routing layers, each of the plurality of routing layers made of a same material as a corresponding one of the plurality of conductive layers included in the touch sensor, and the plurality of routing layers arranged in a same stacking sequence as the stacking sequence of the plurality of conductive layers of the touch sensor.

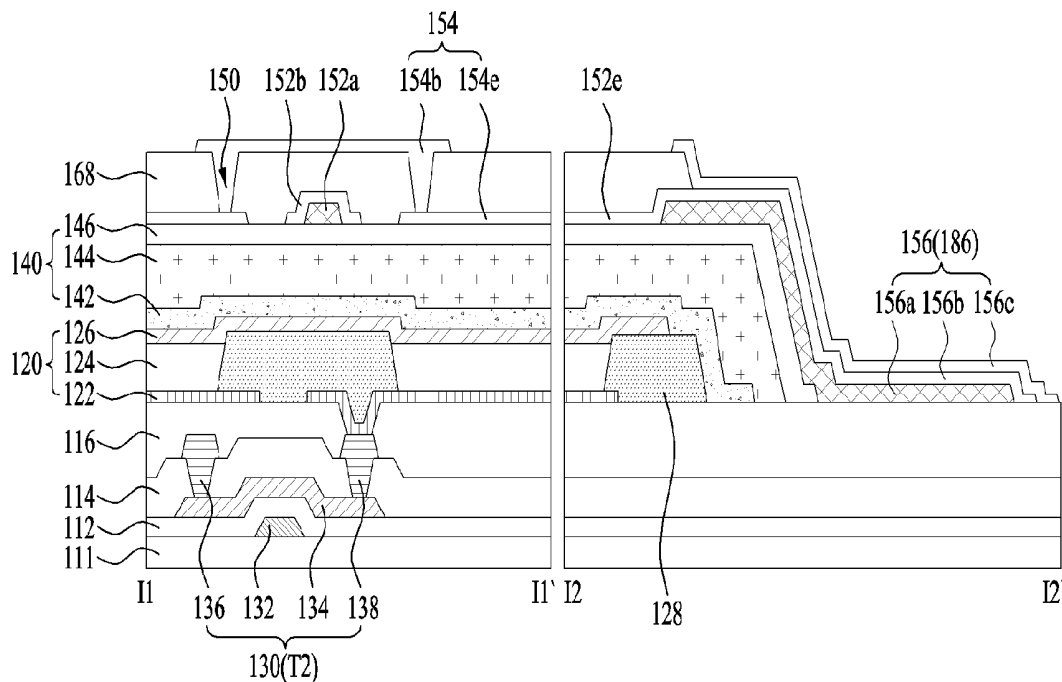


FIG.1

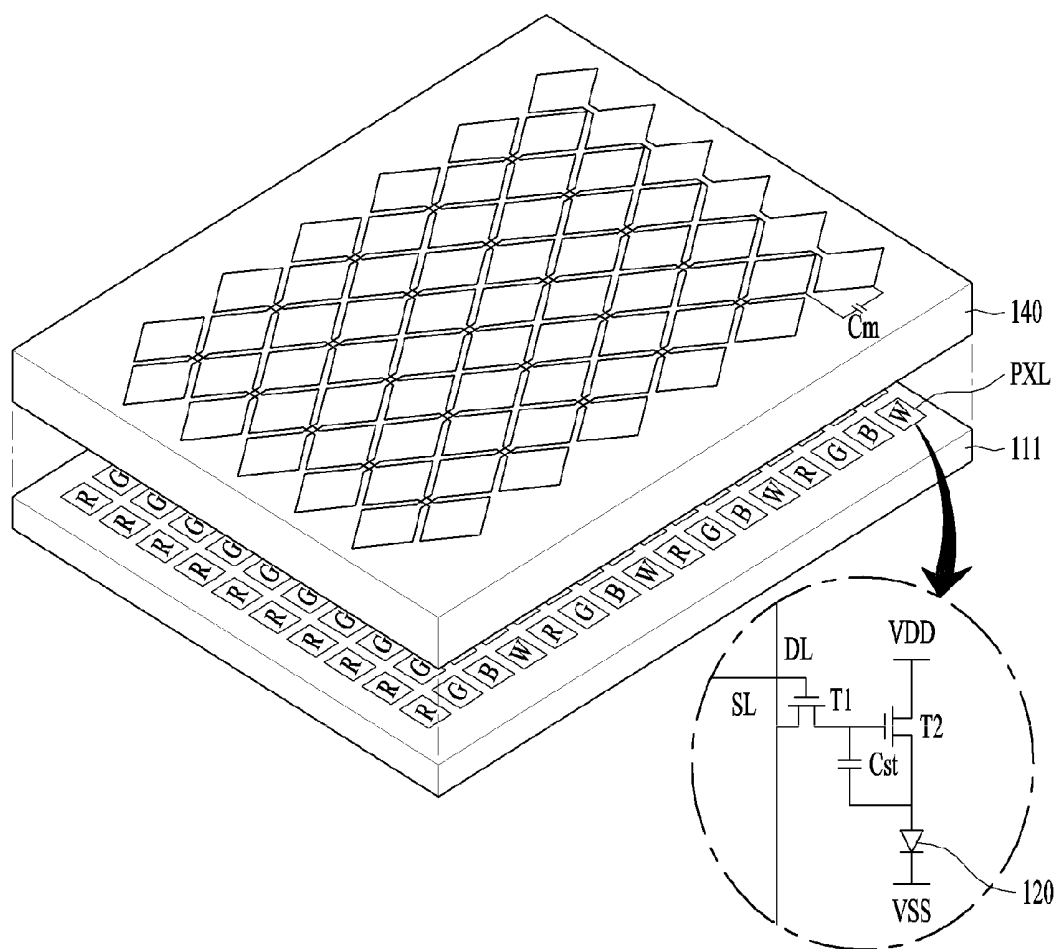


FIG.2

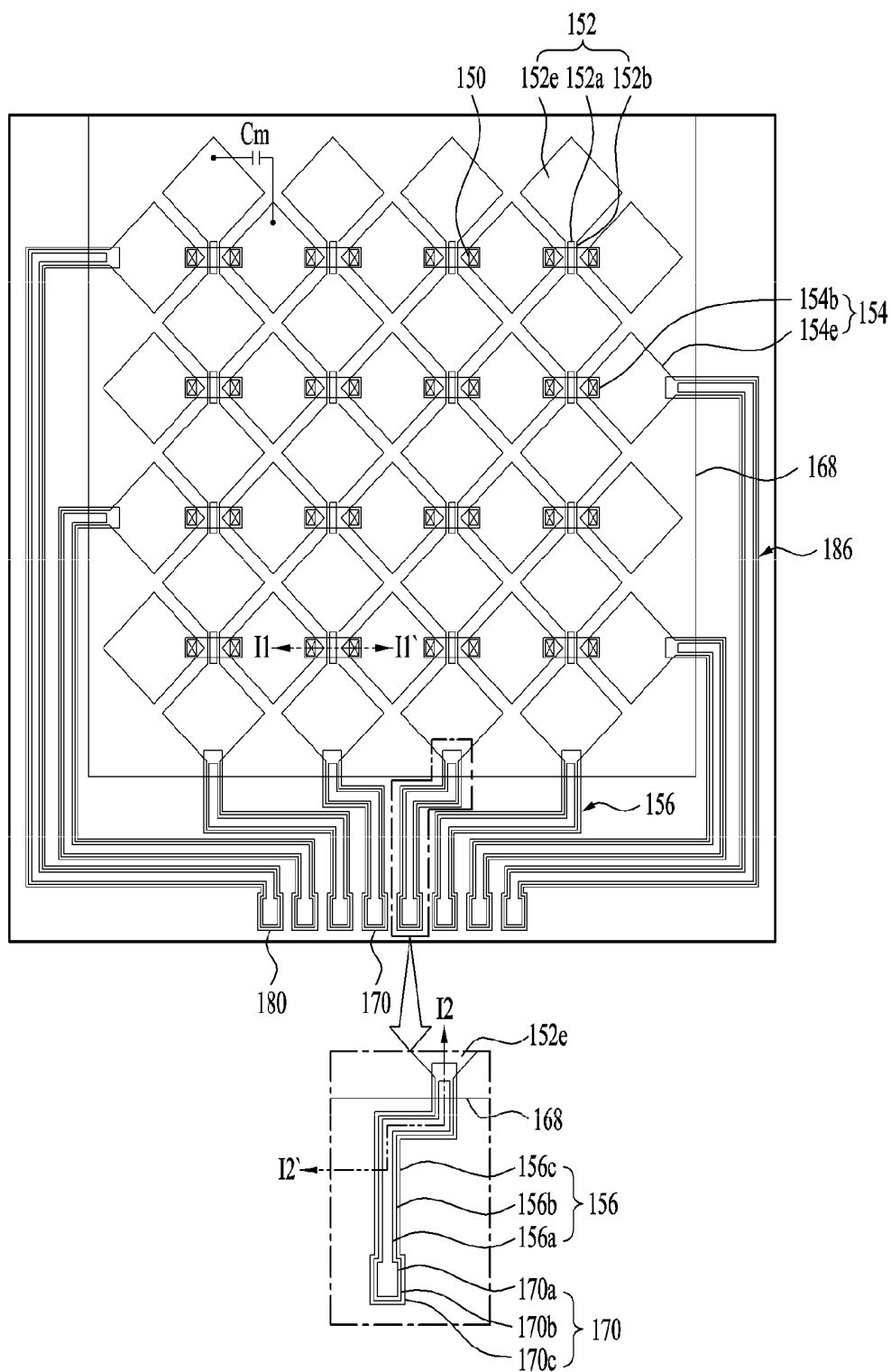


FIG.3

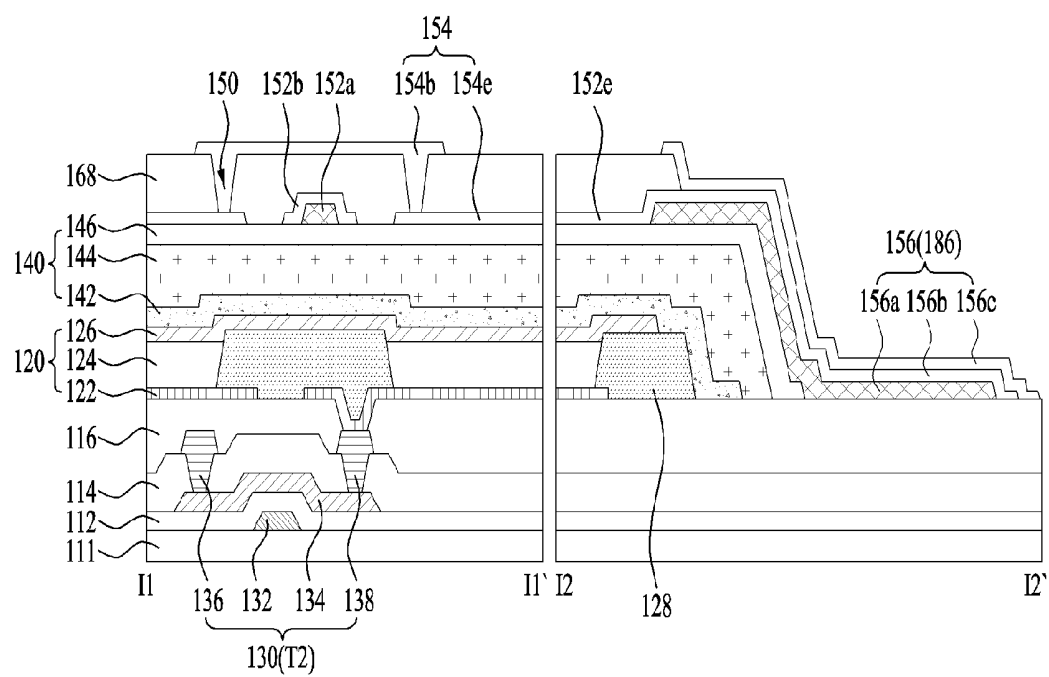


FIG.4A

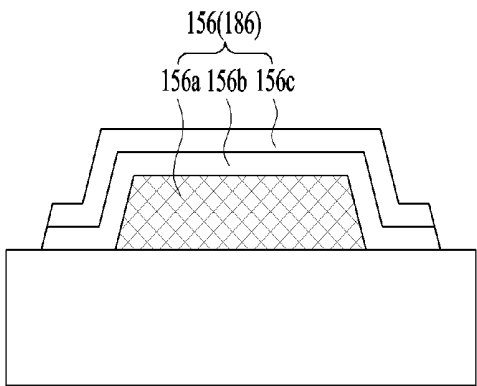


FIG.4B

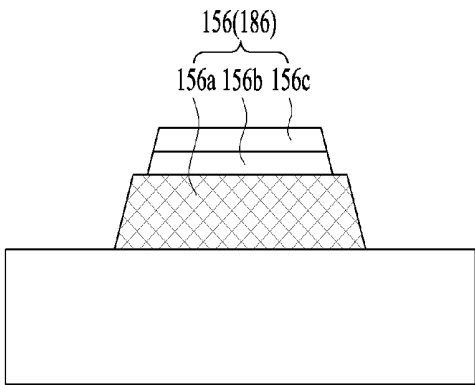


FIG.4C

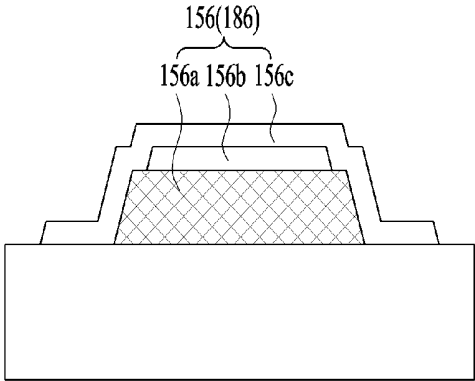


FIG.5A

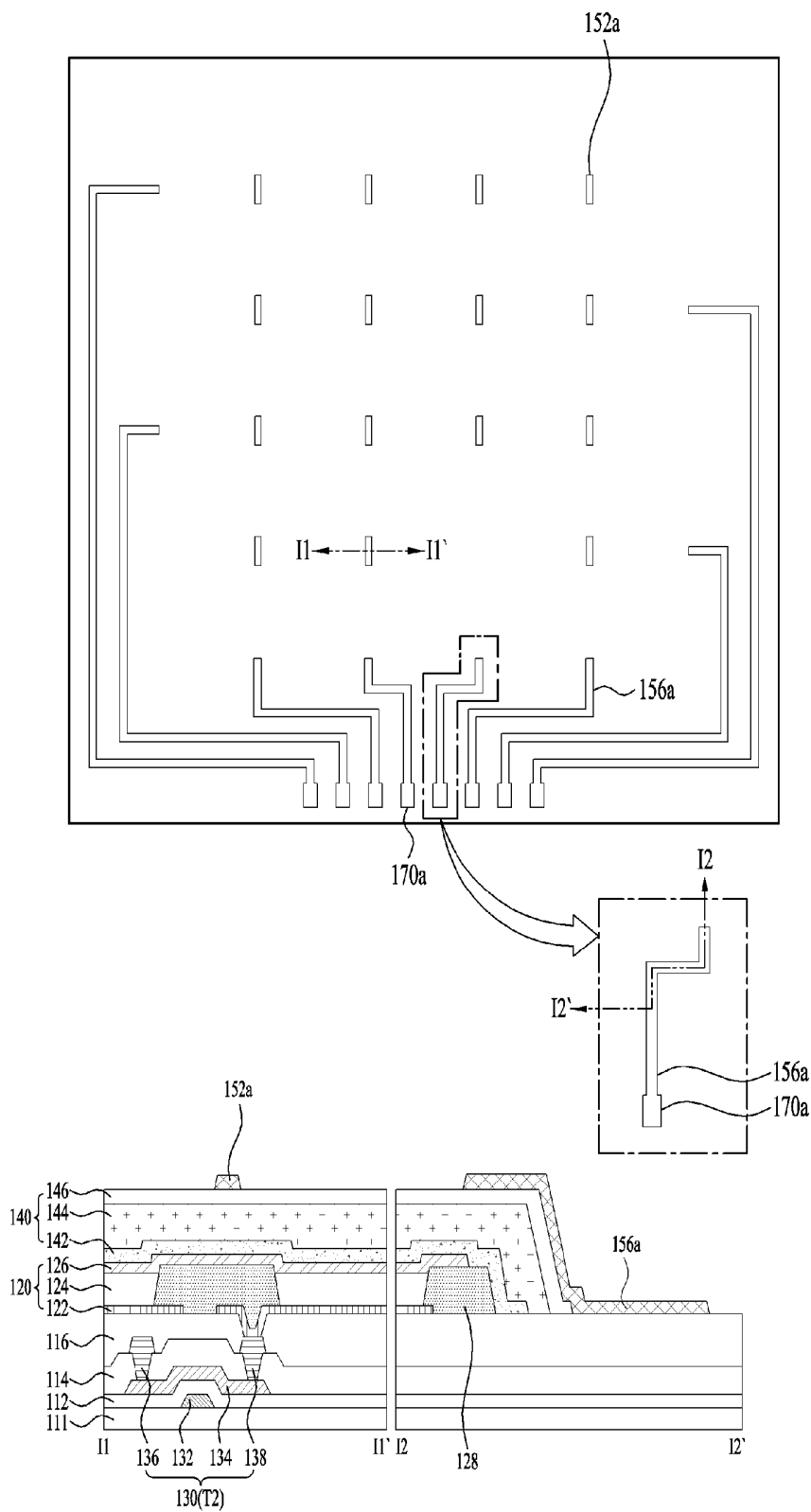


FIG.5B

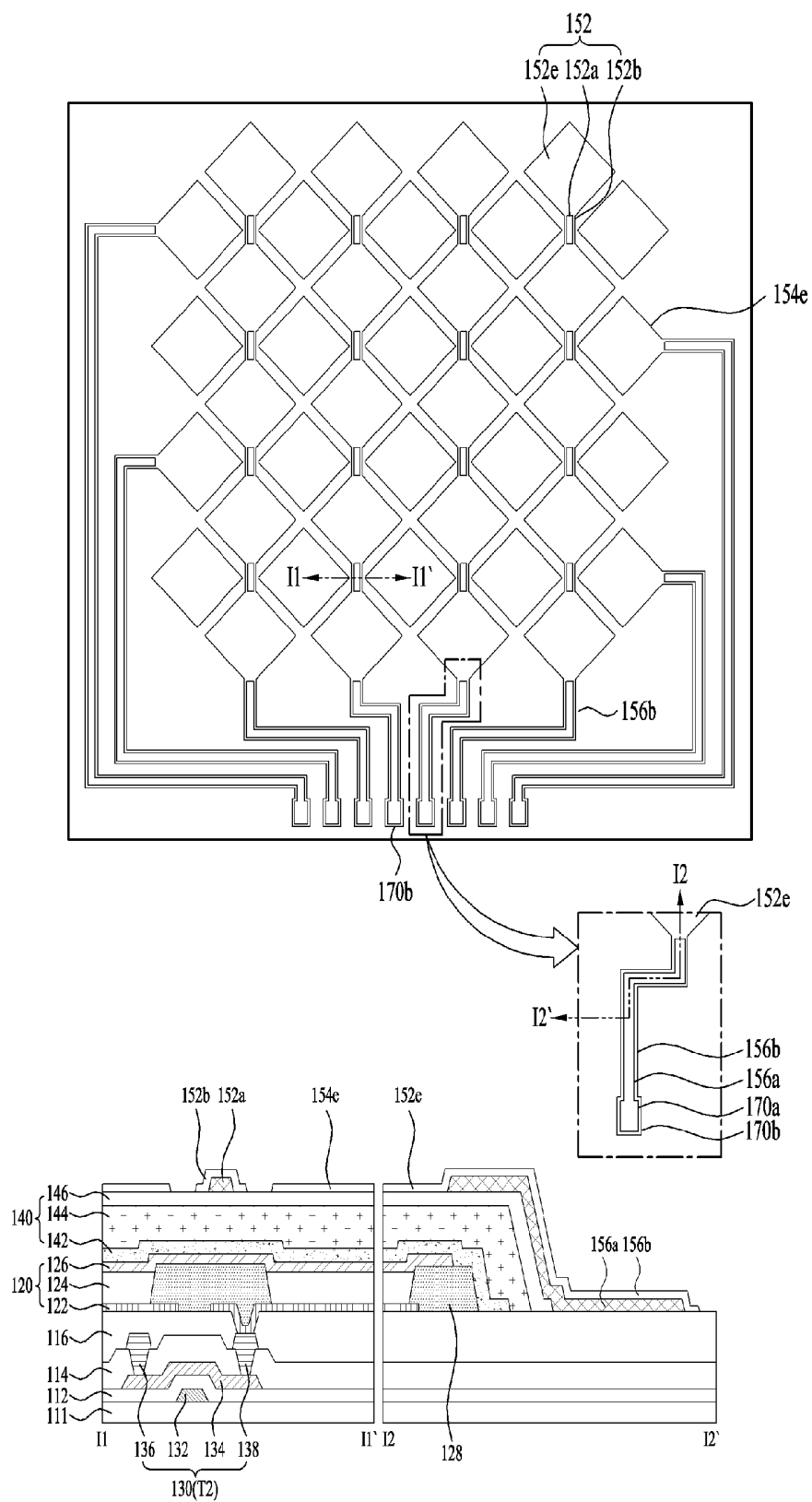


FIG.5C

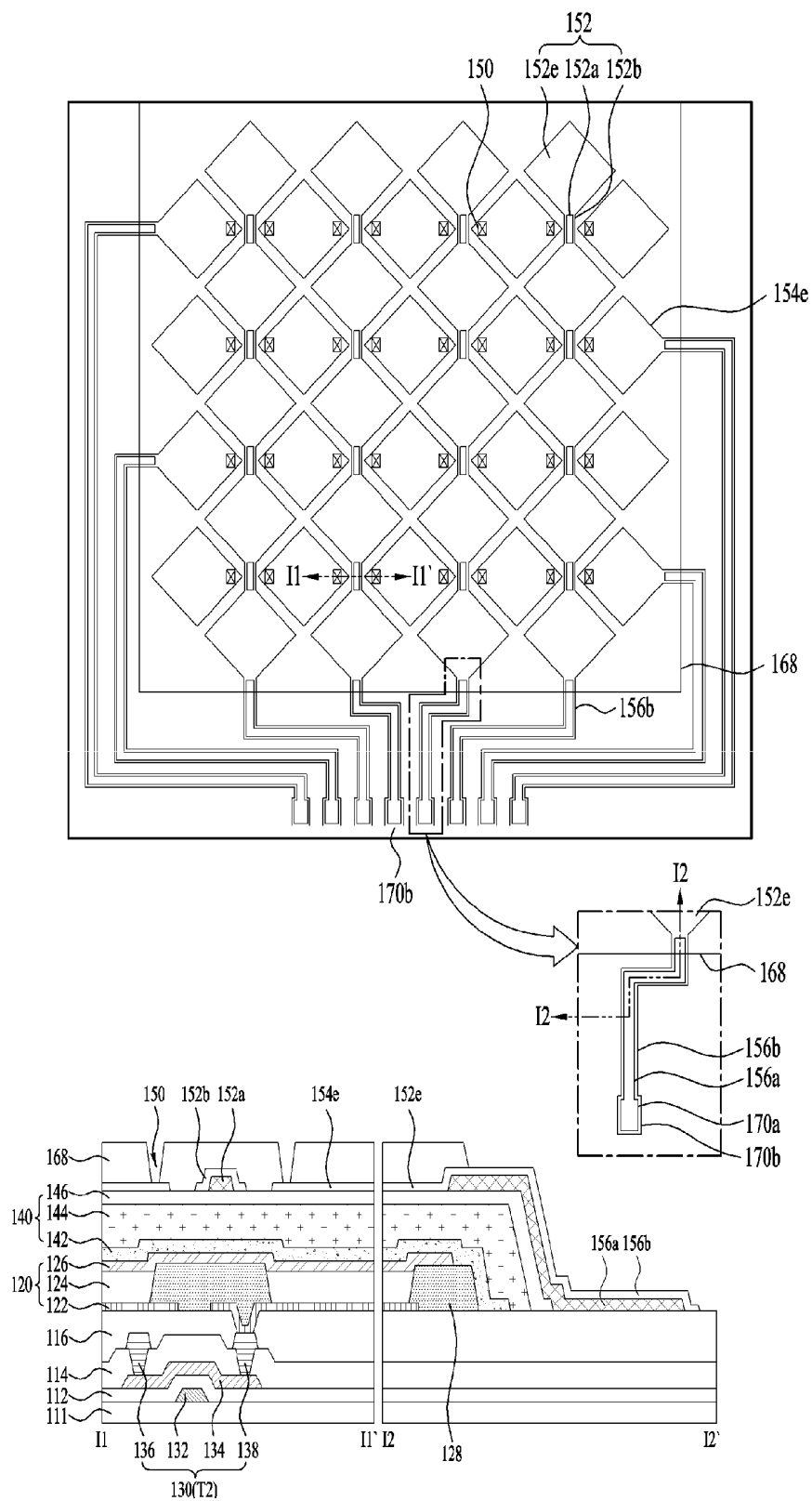


FIG.5D

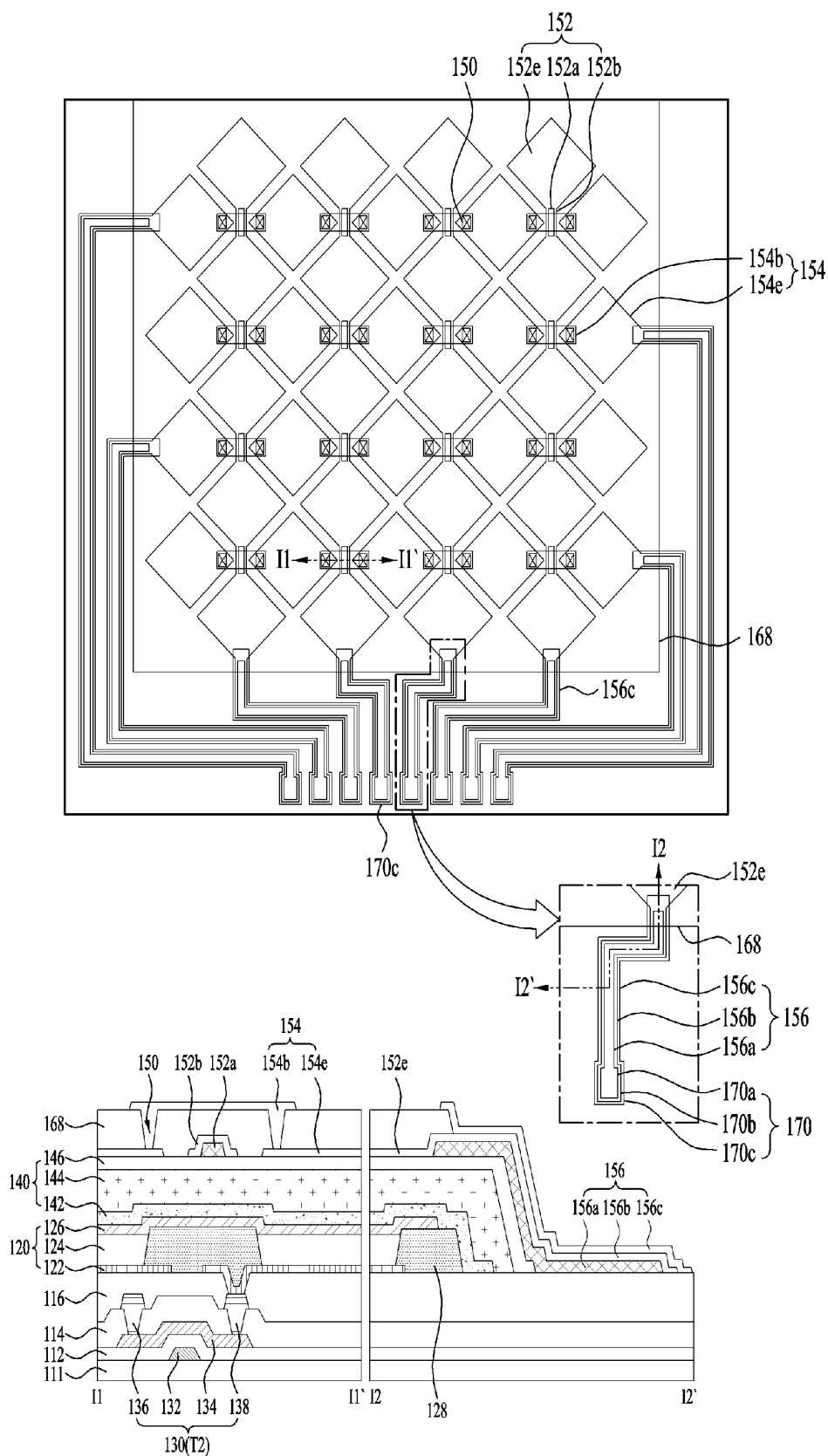


FIG.6

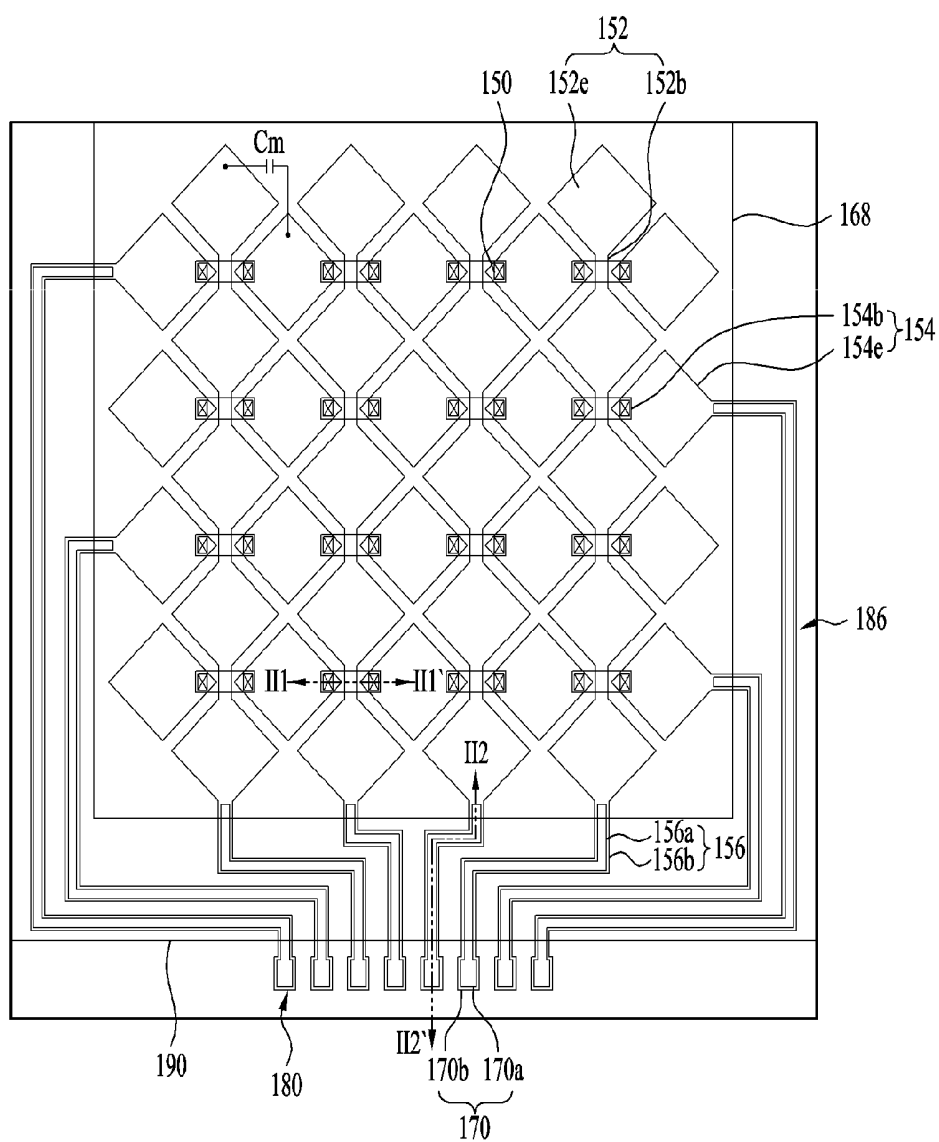


FIG.7

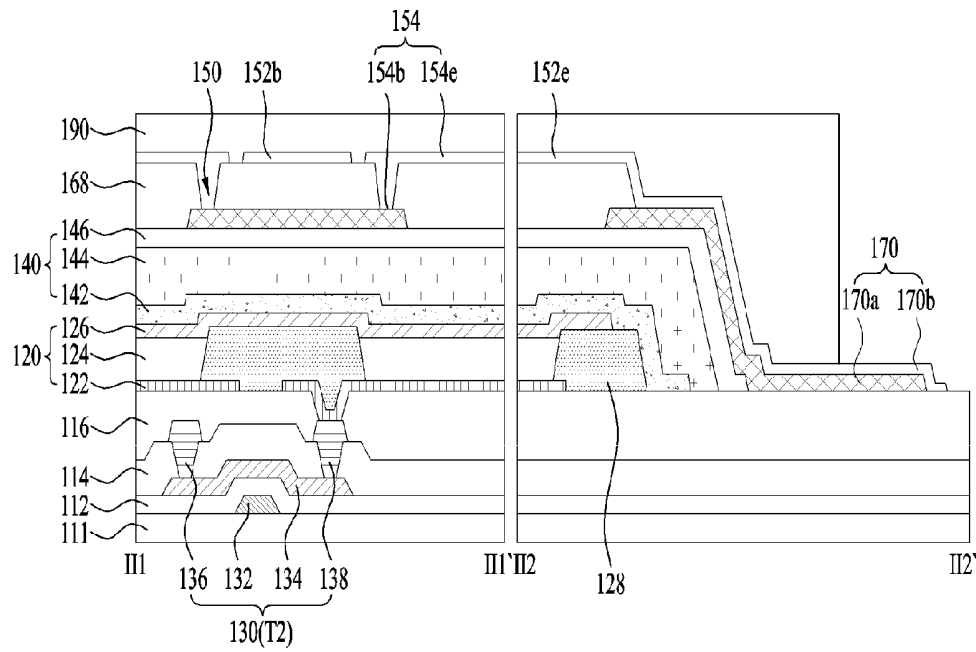


FIG.8A

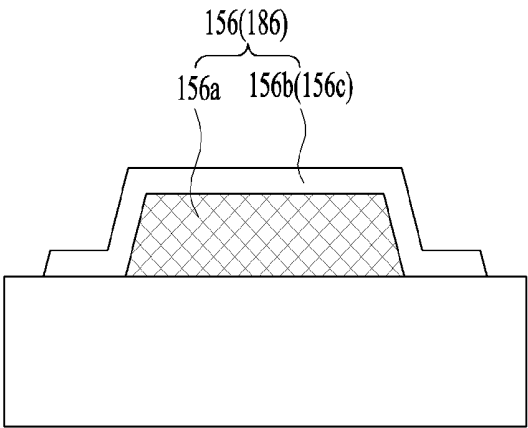


FIG.8B

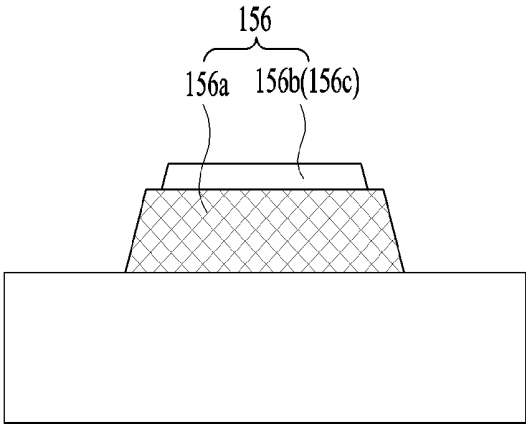


FIG.9A

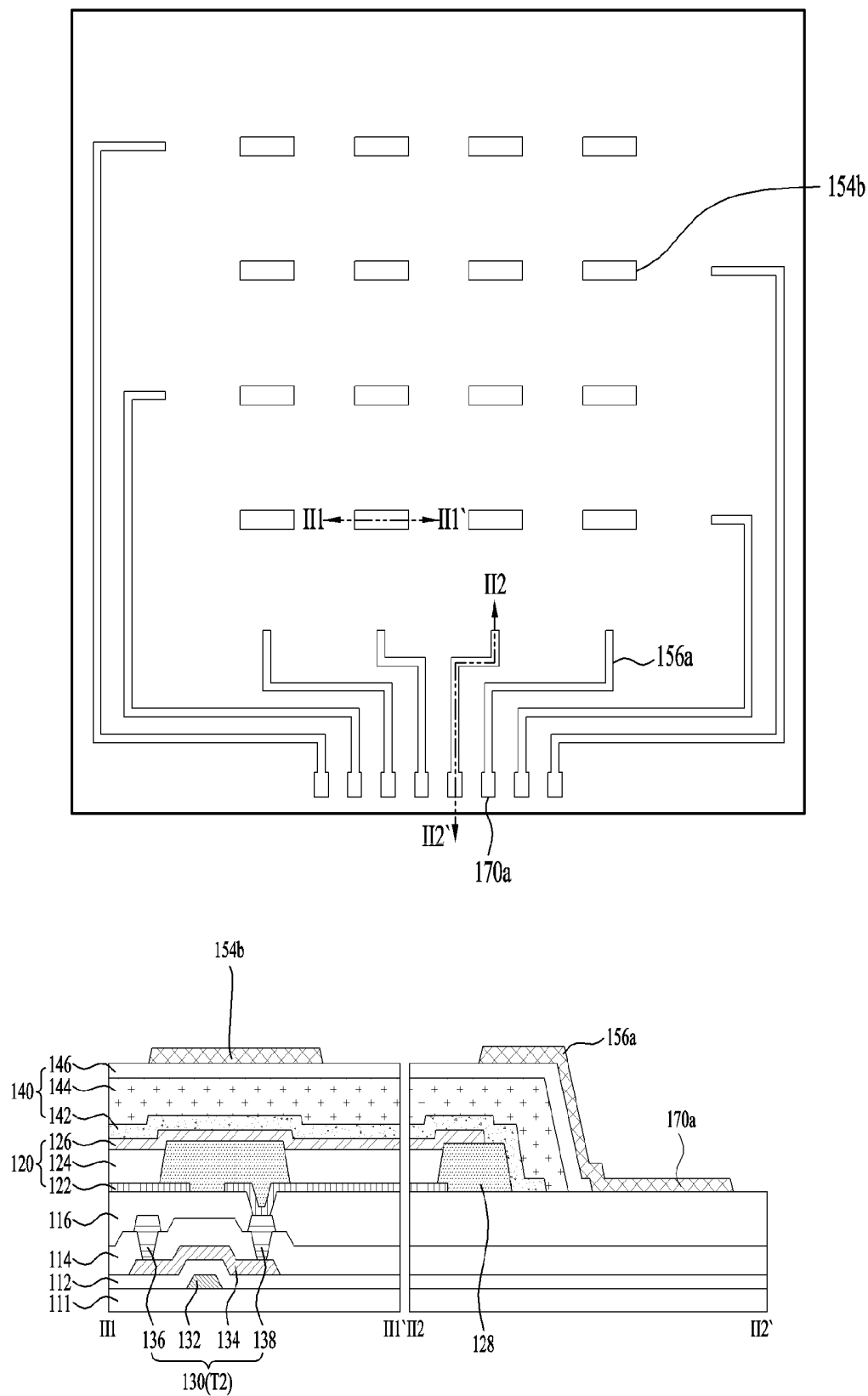


FIG.9B

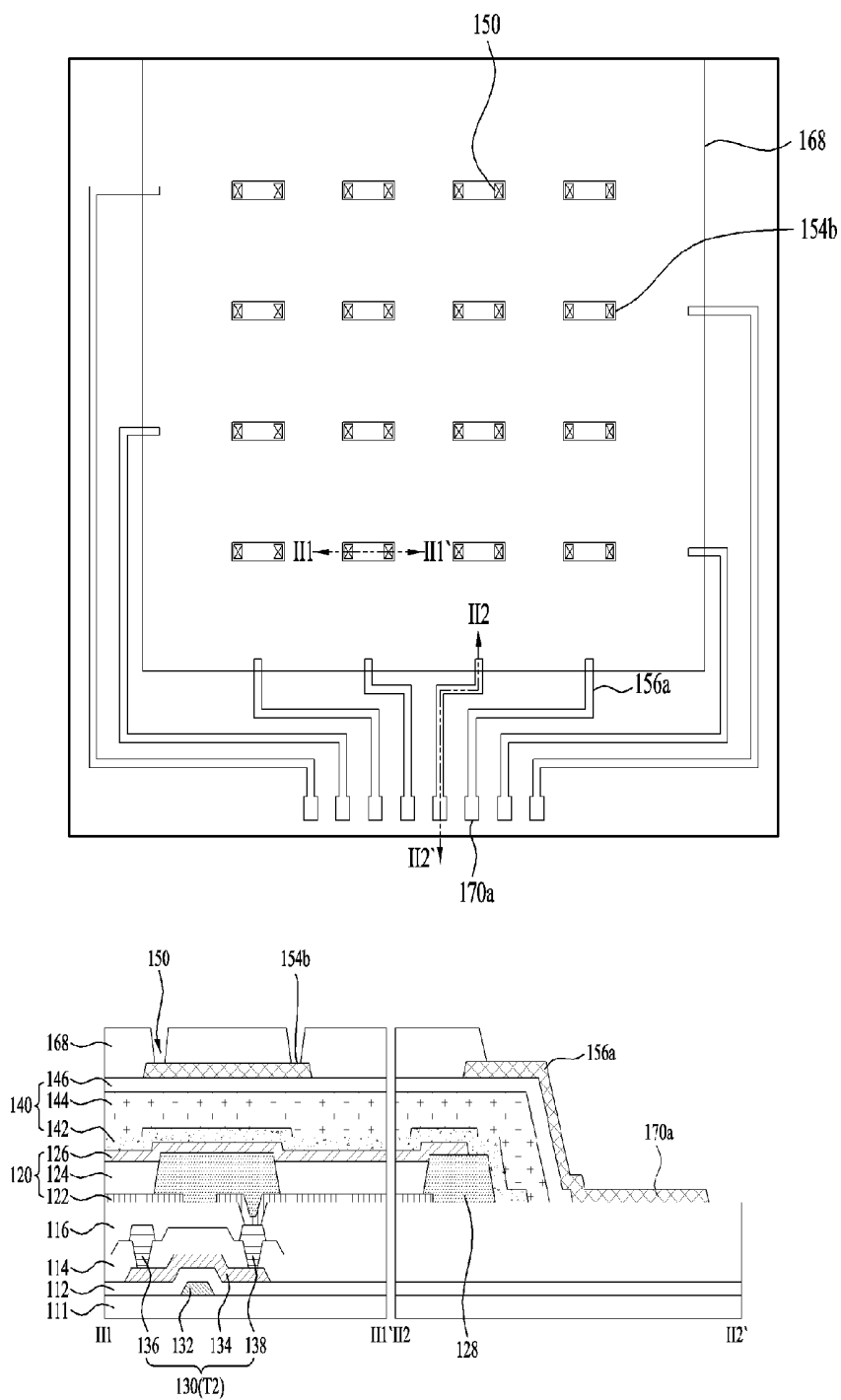


FIG.9C

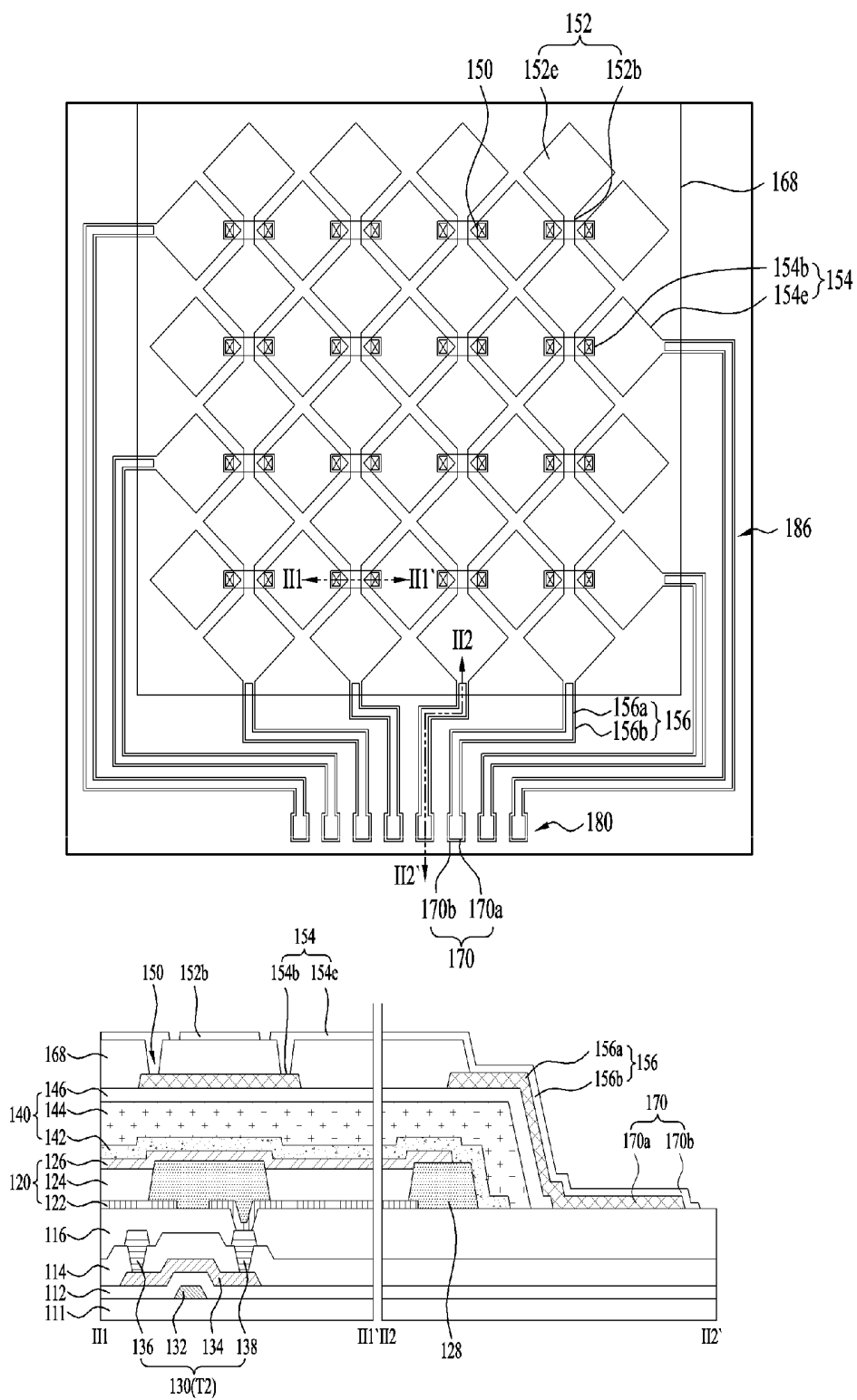


FIG.9D

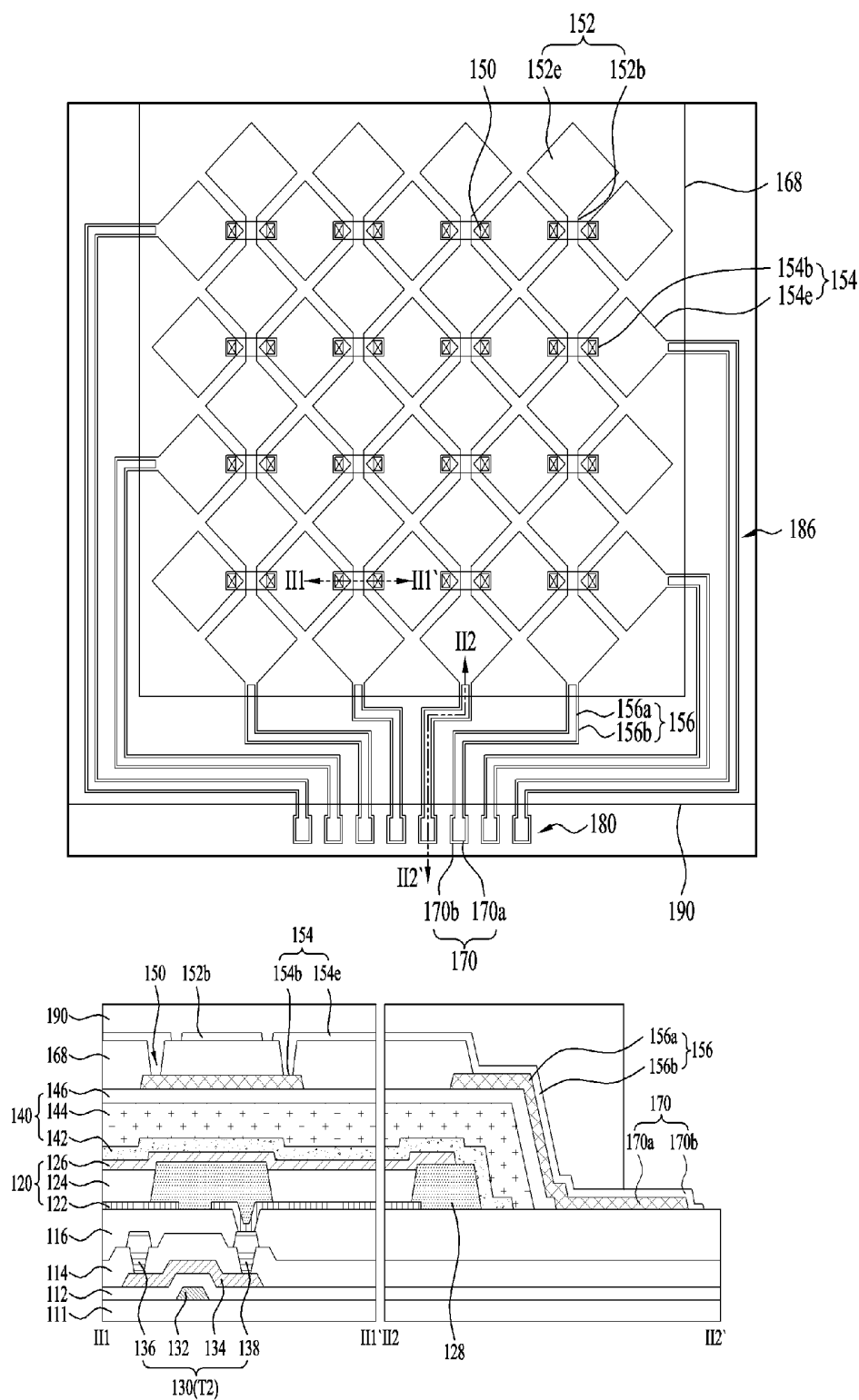


FIG.10

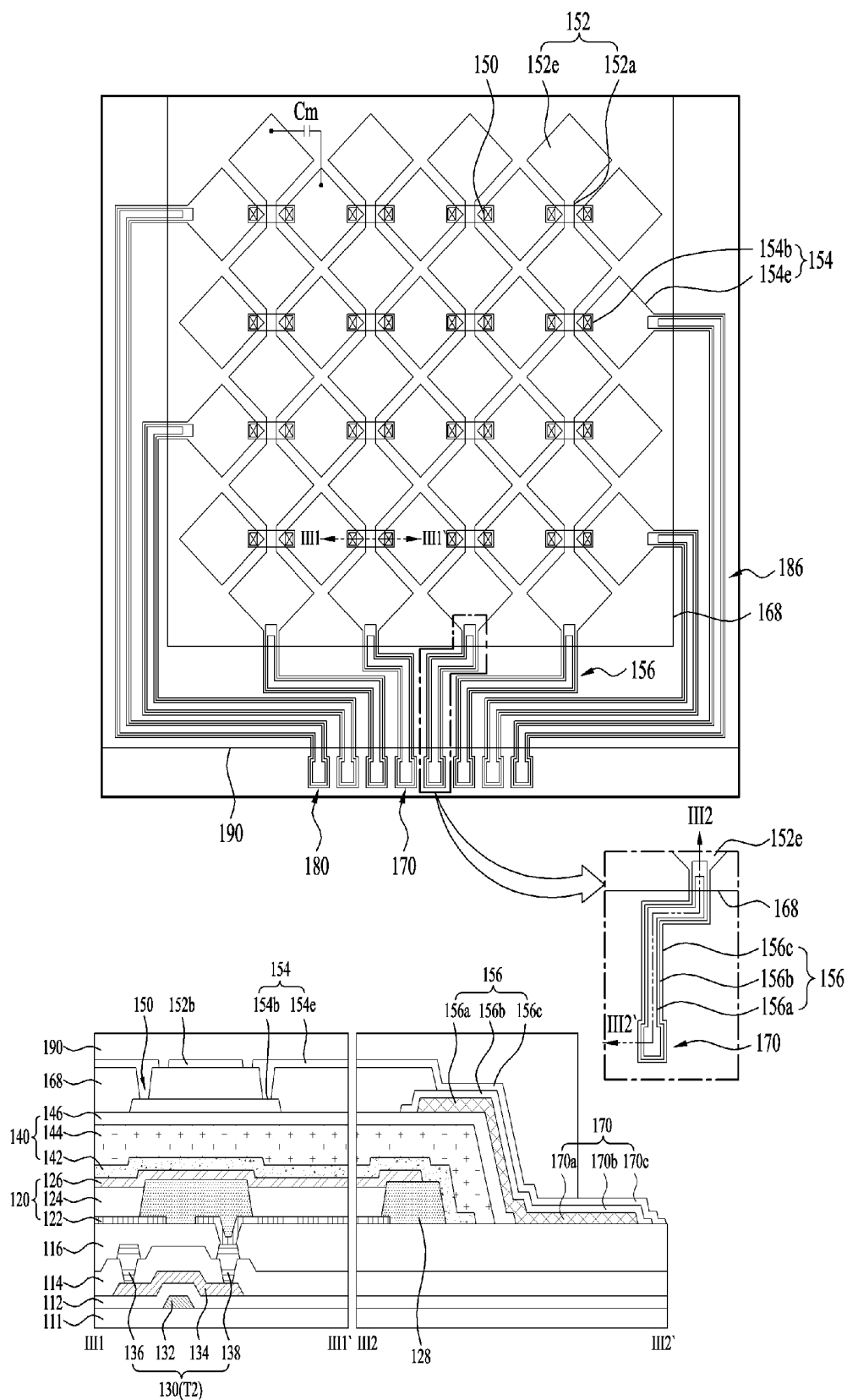


FIG.11A

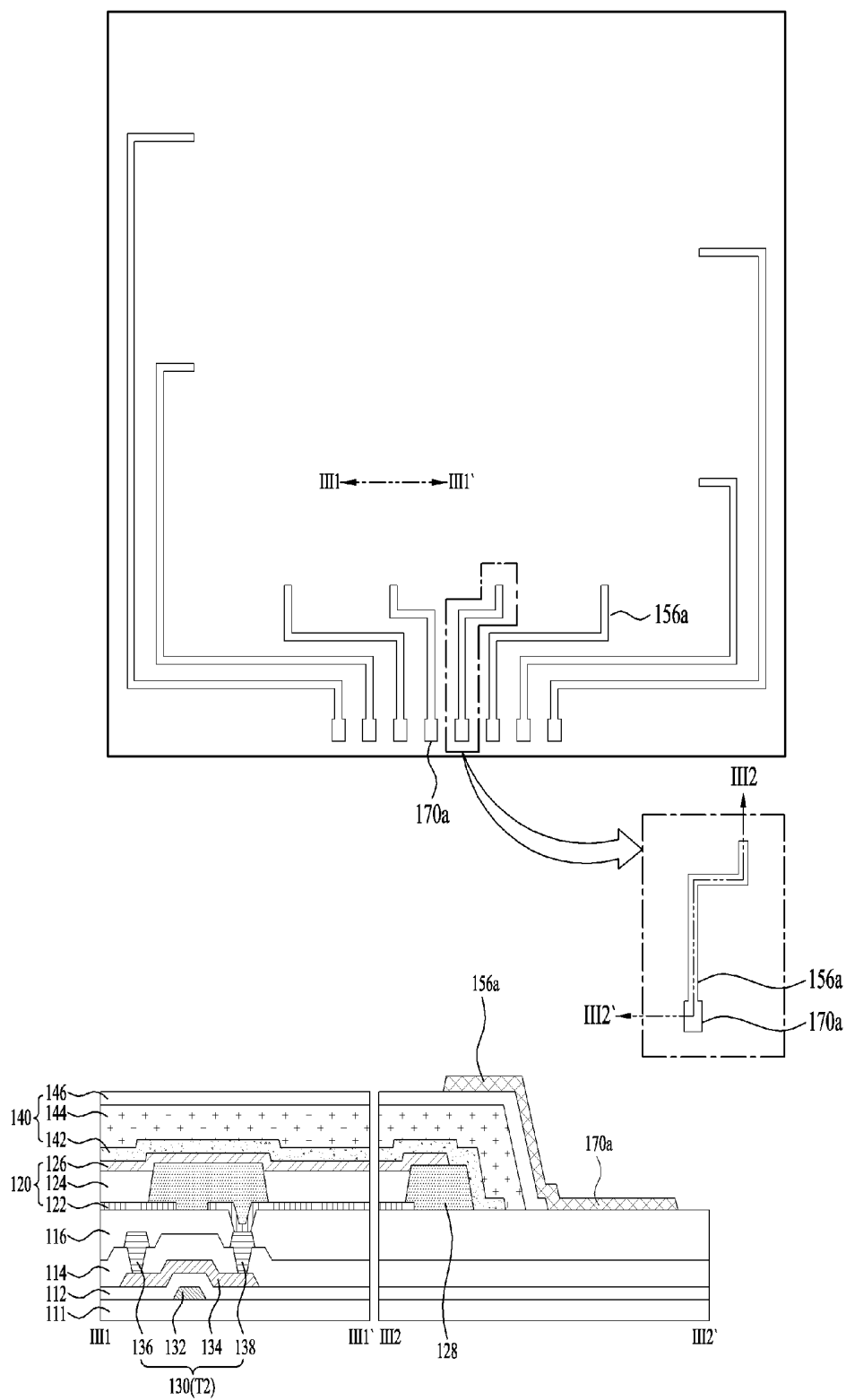


FIG.11B

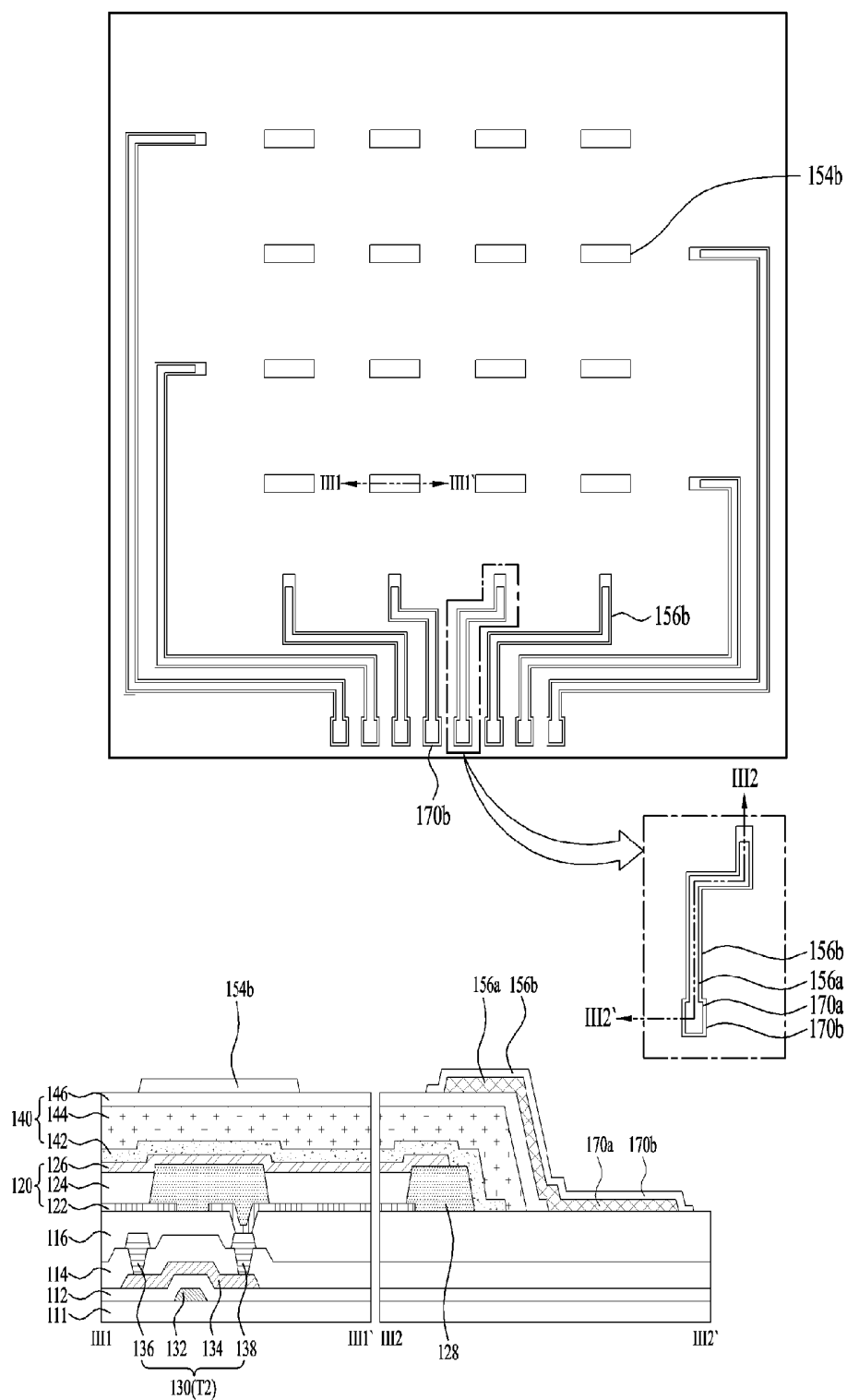


FIG.11C

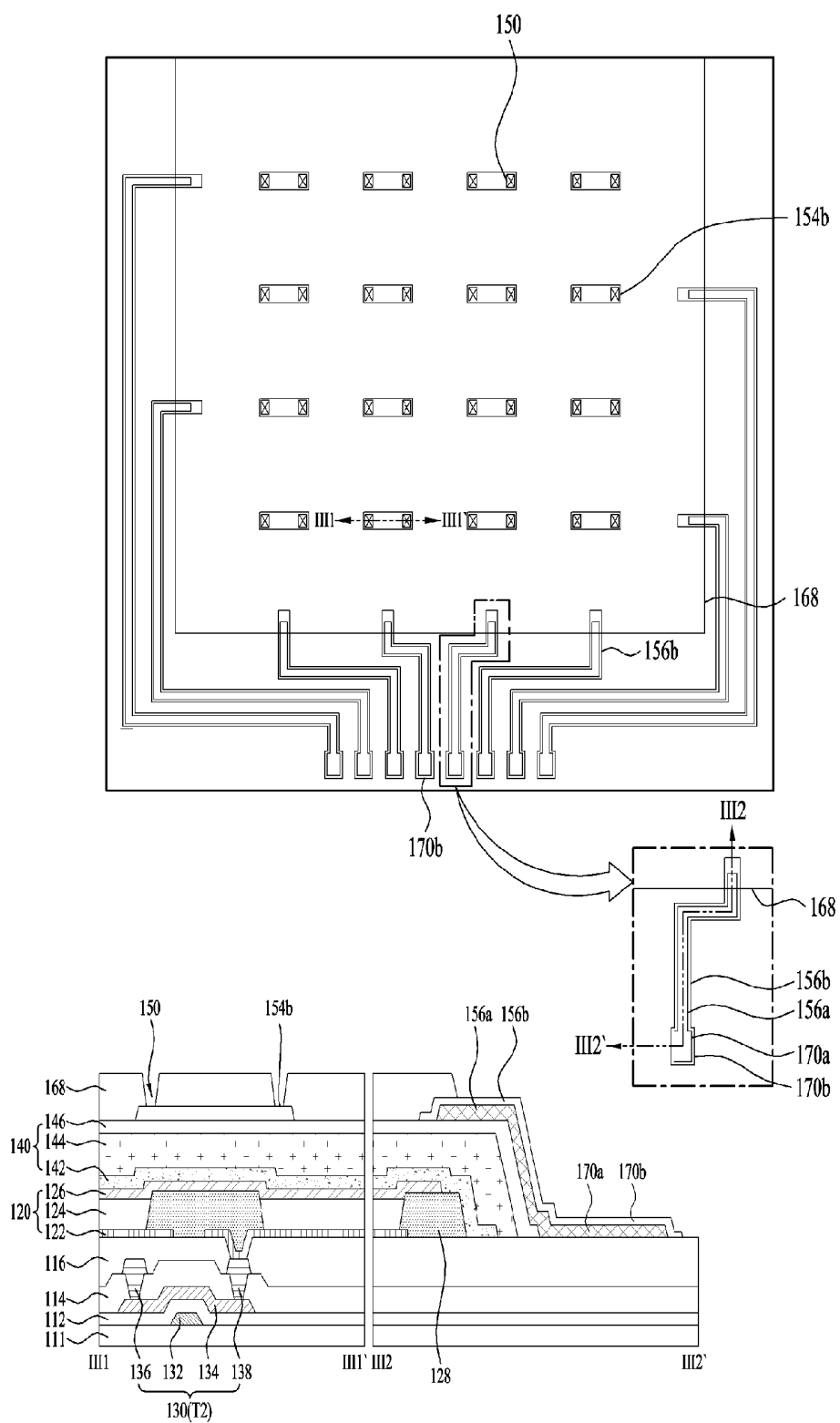


FIG.11D

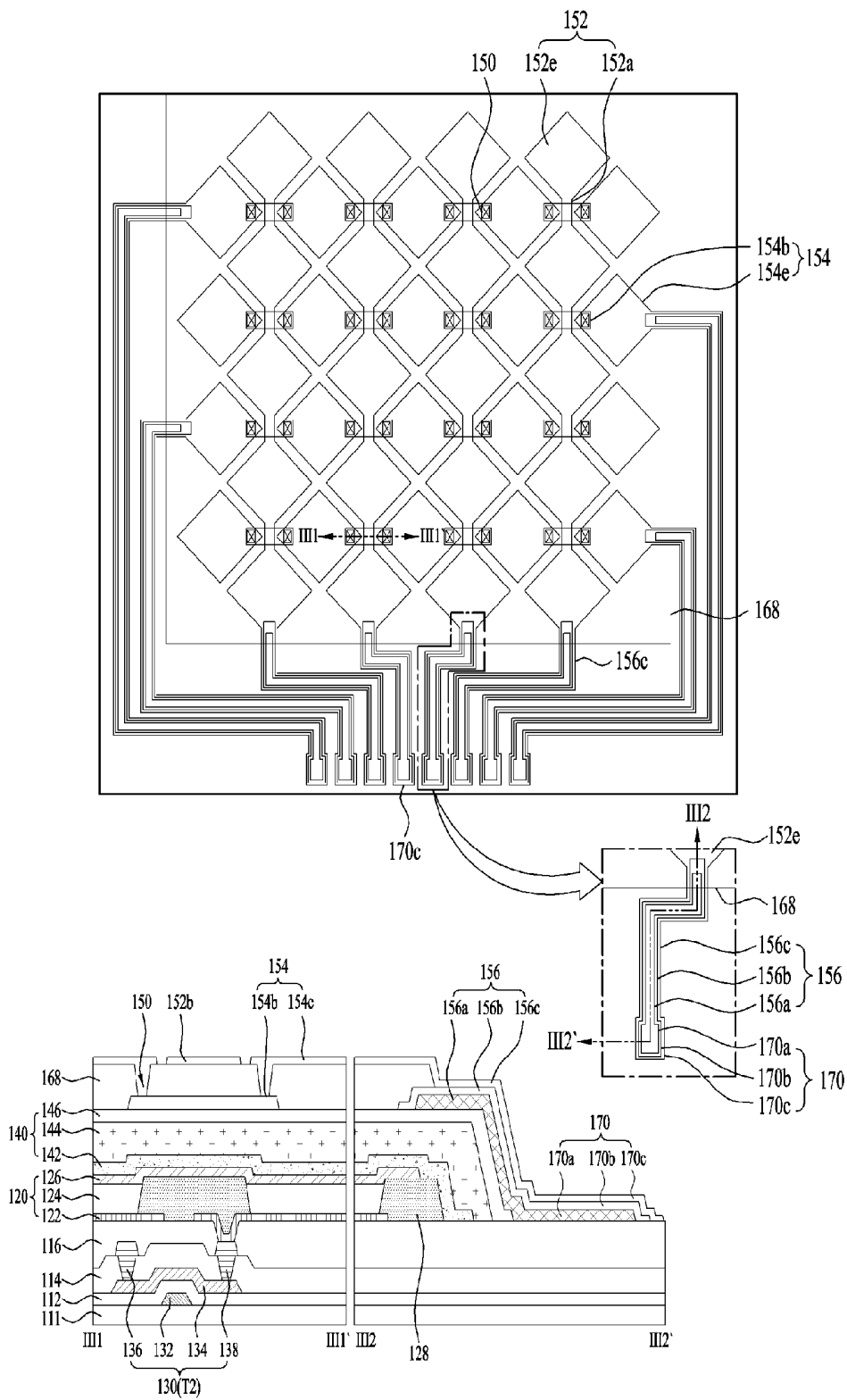


FIG.11E

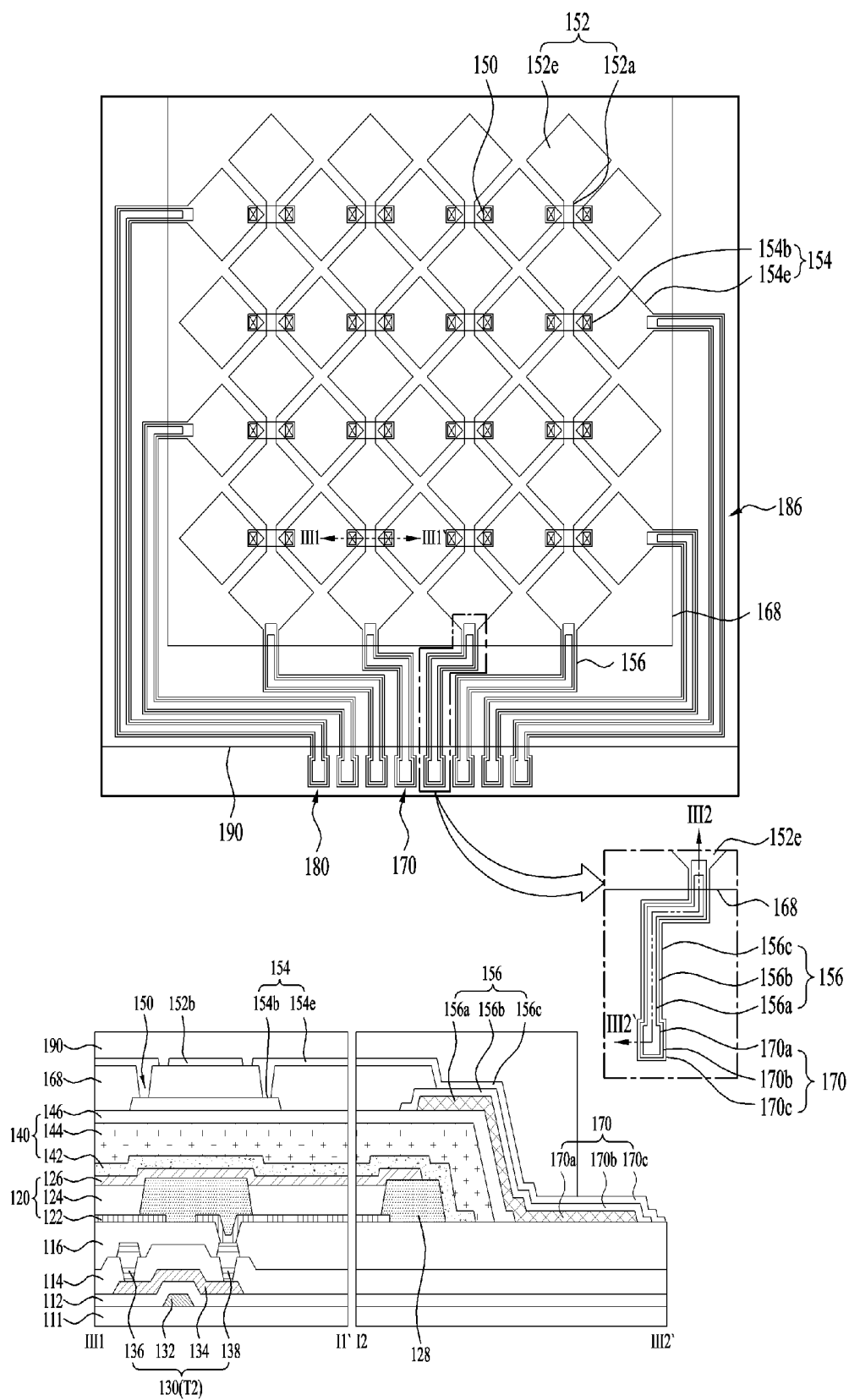


FIG.12

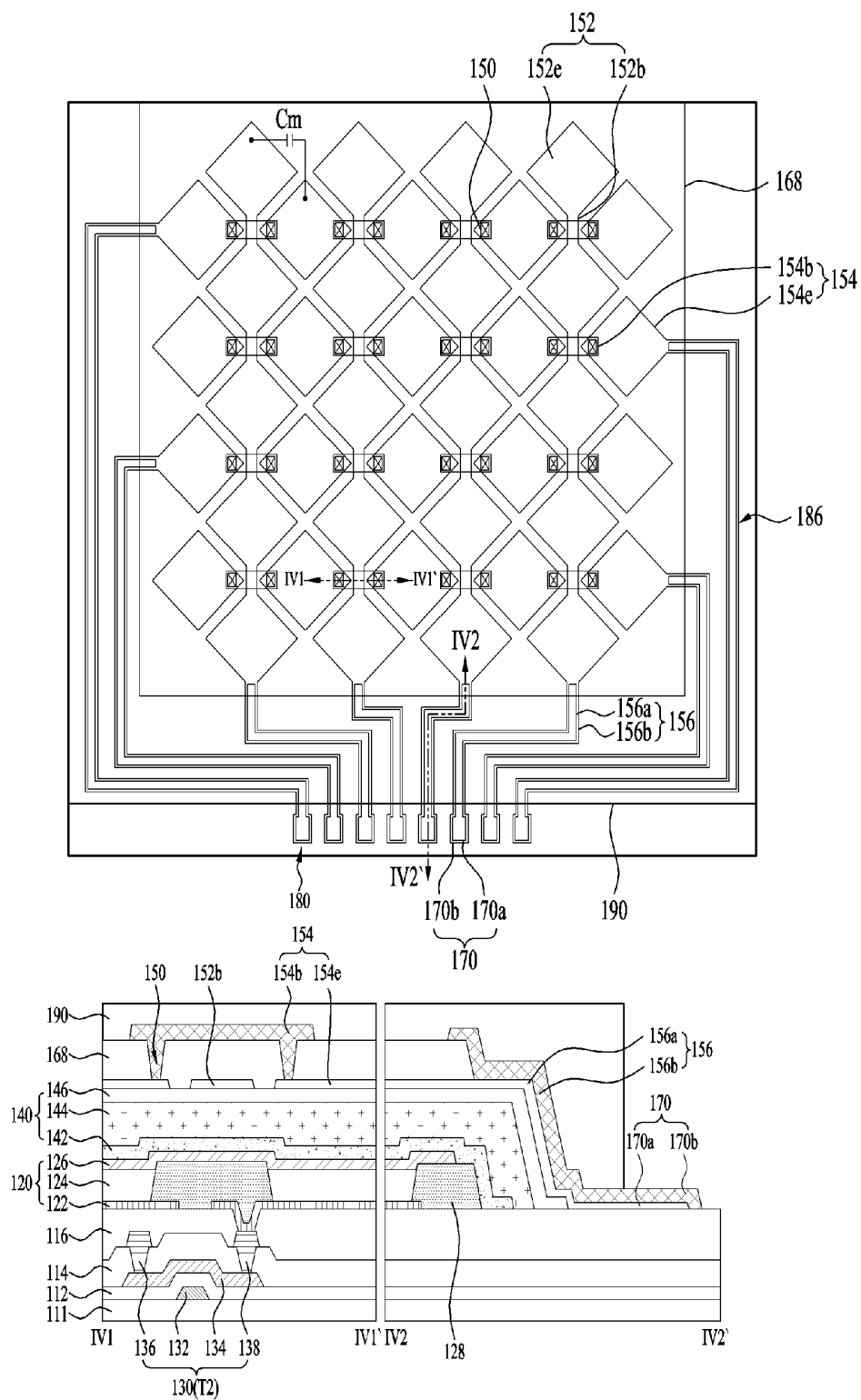


FIG.13A

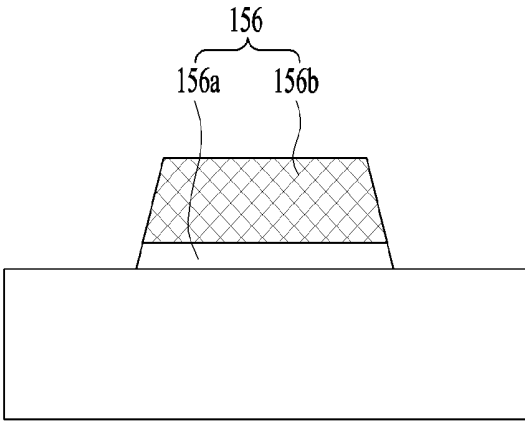


FIG.13B

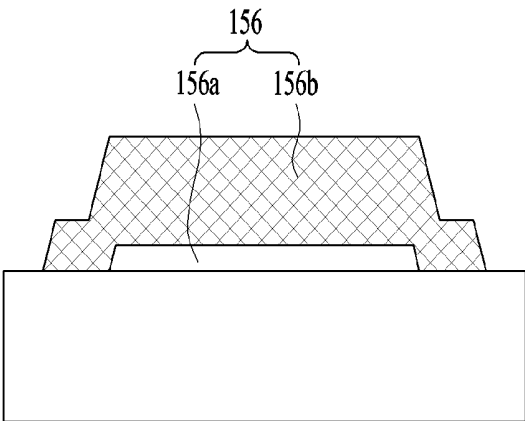


FIG.13C

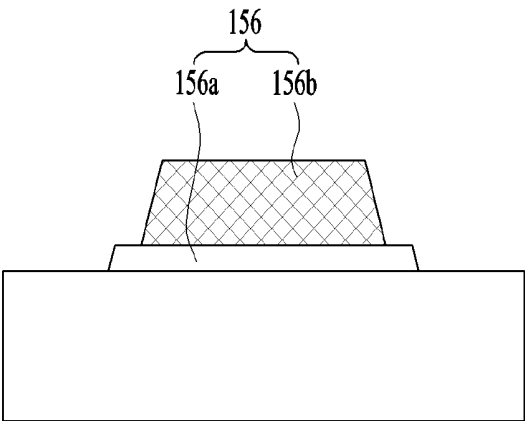


FIG.14A

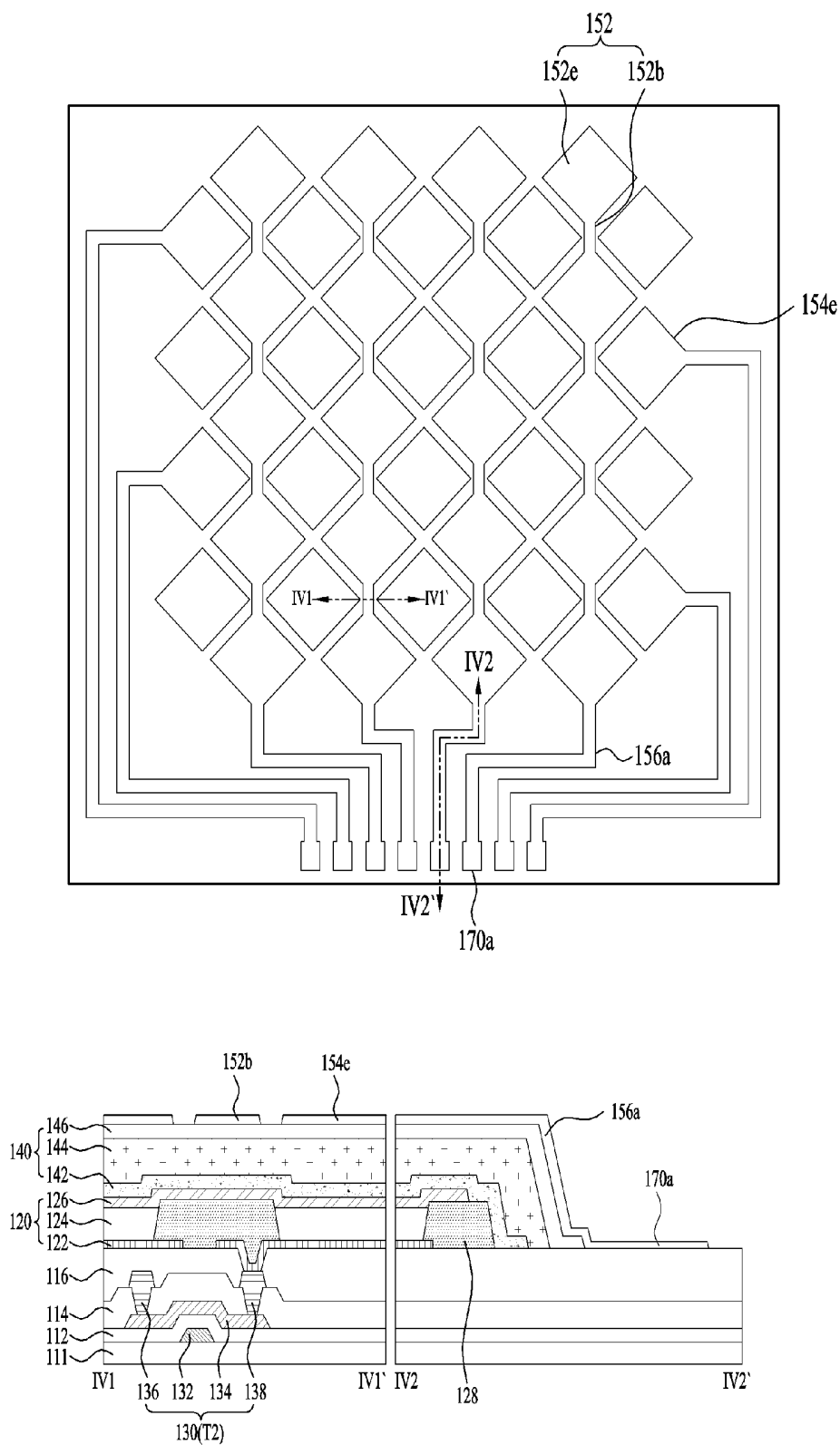


FIG.14B

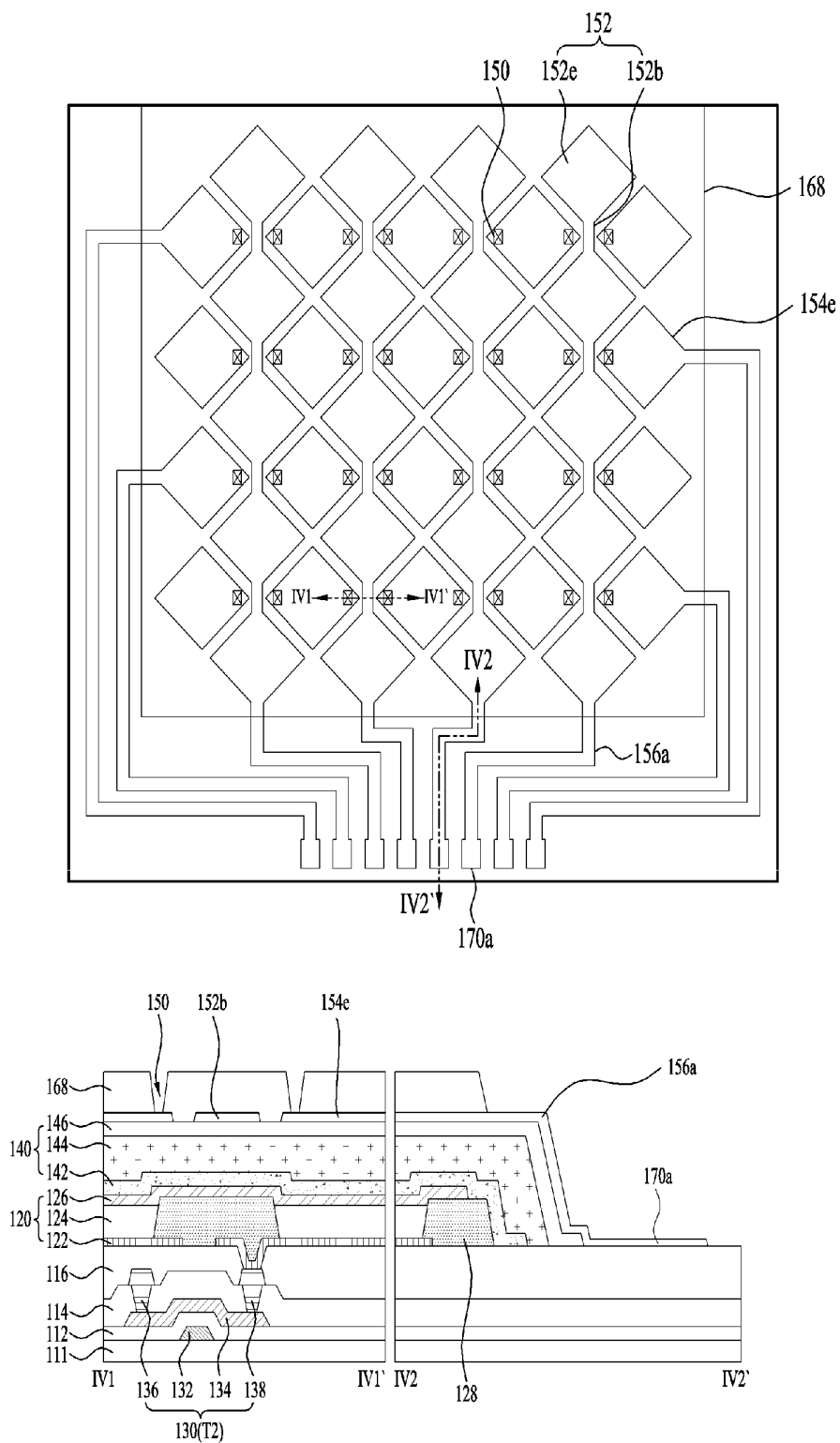


FIG.14C

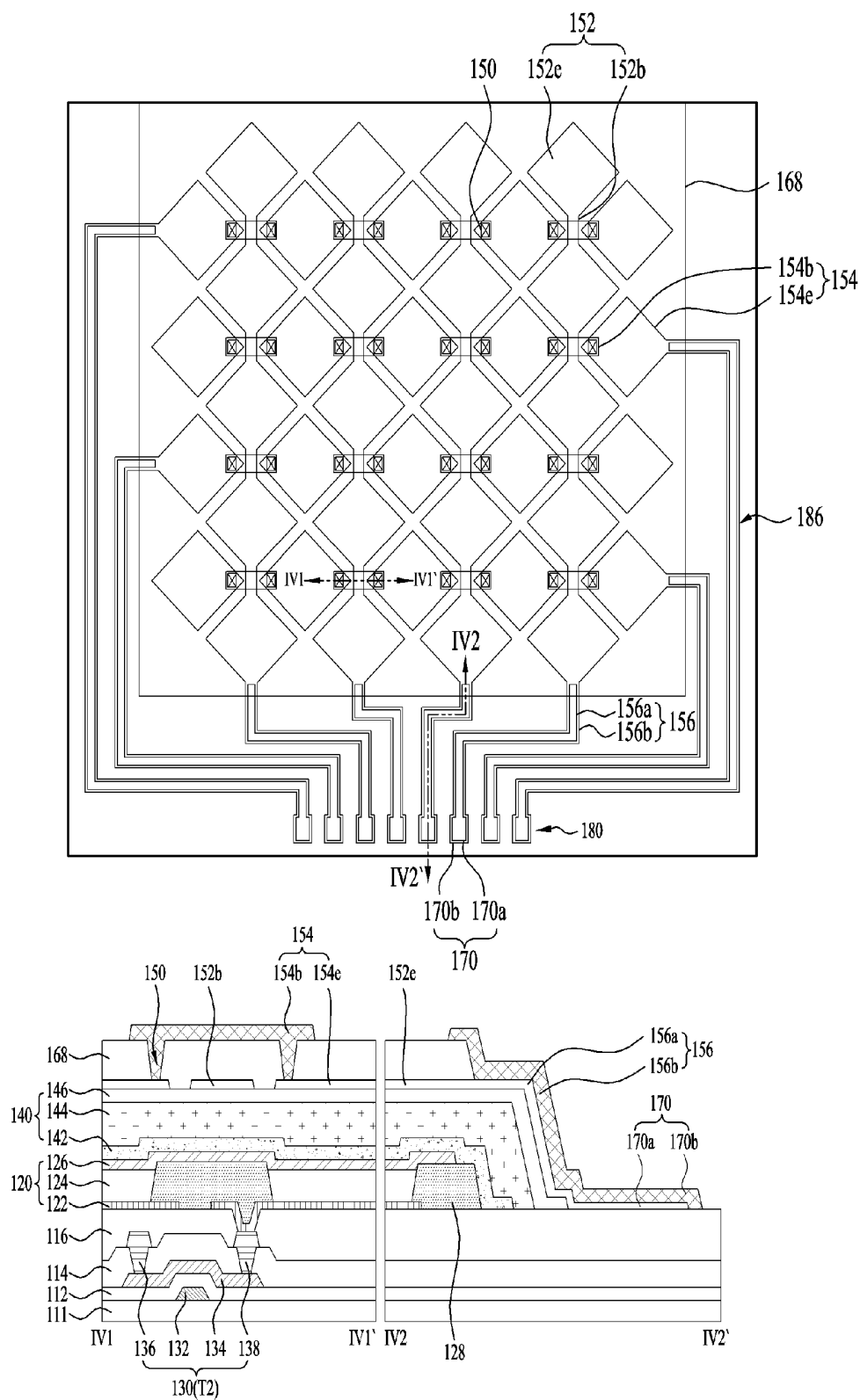


FIG.14D

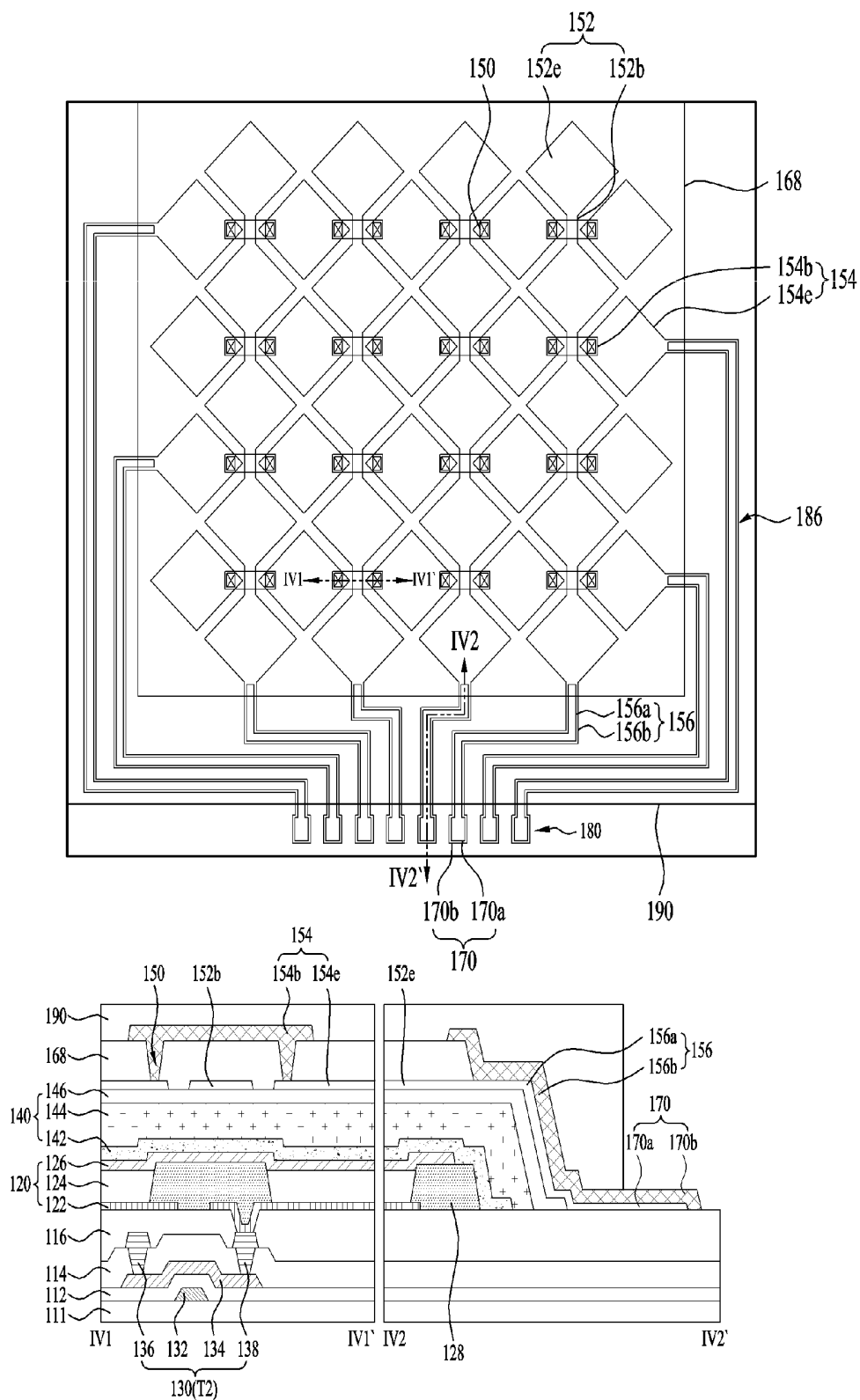


FIG.15

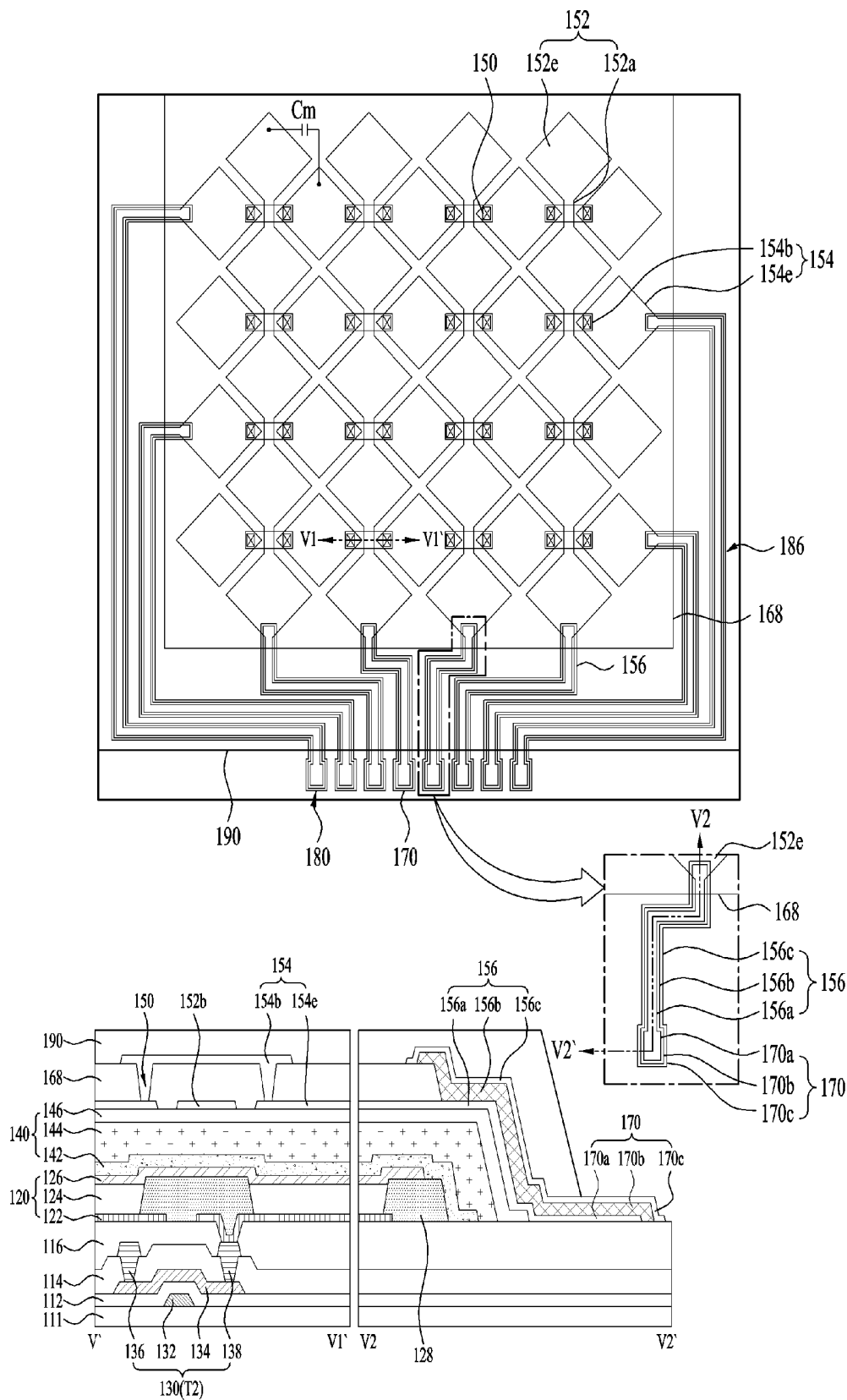


FIG.16A

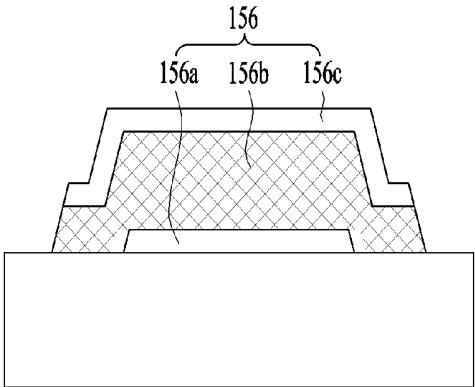


FIG.16B

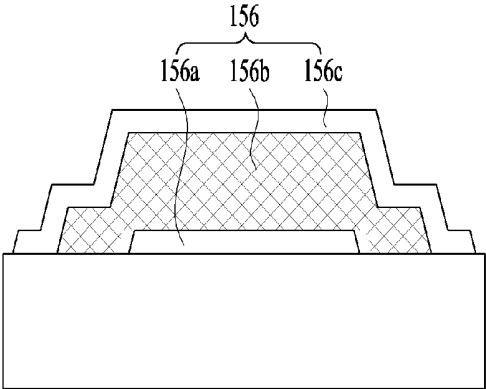


FIG.16C

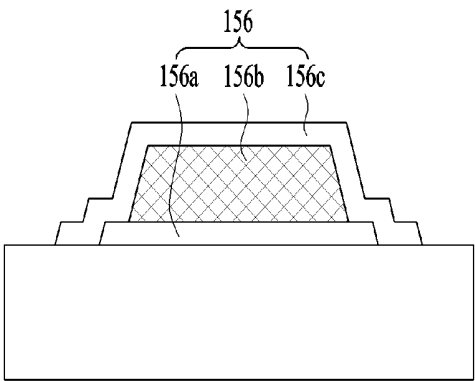


FIG.16D

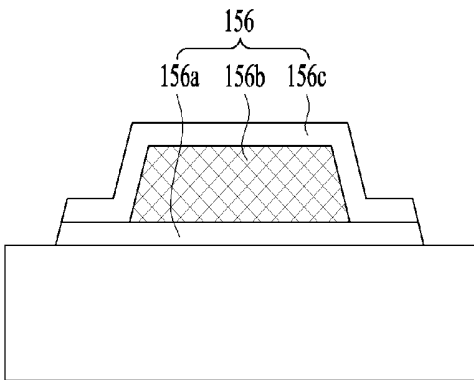


FIG.17A

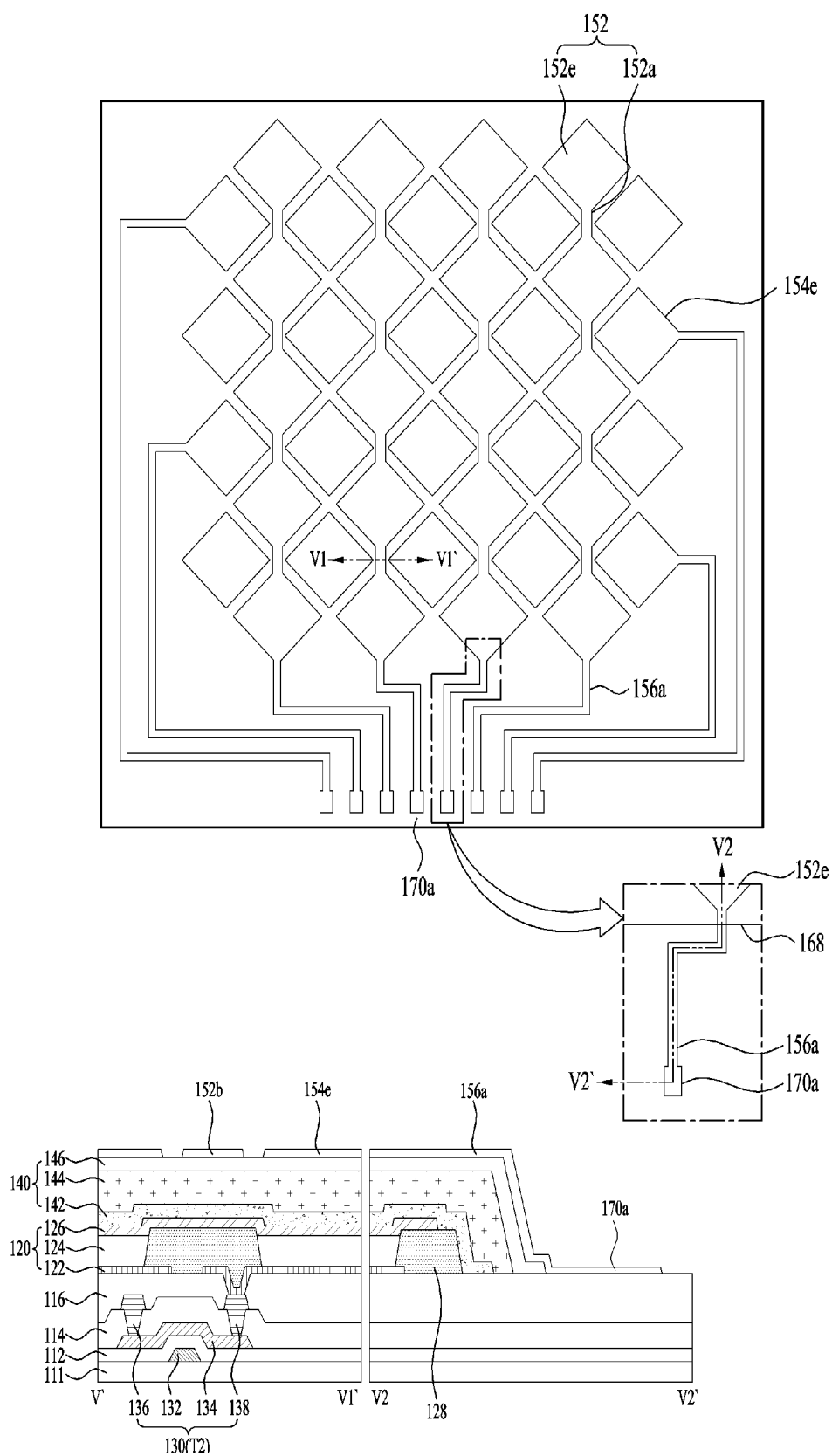


FIG.17B

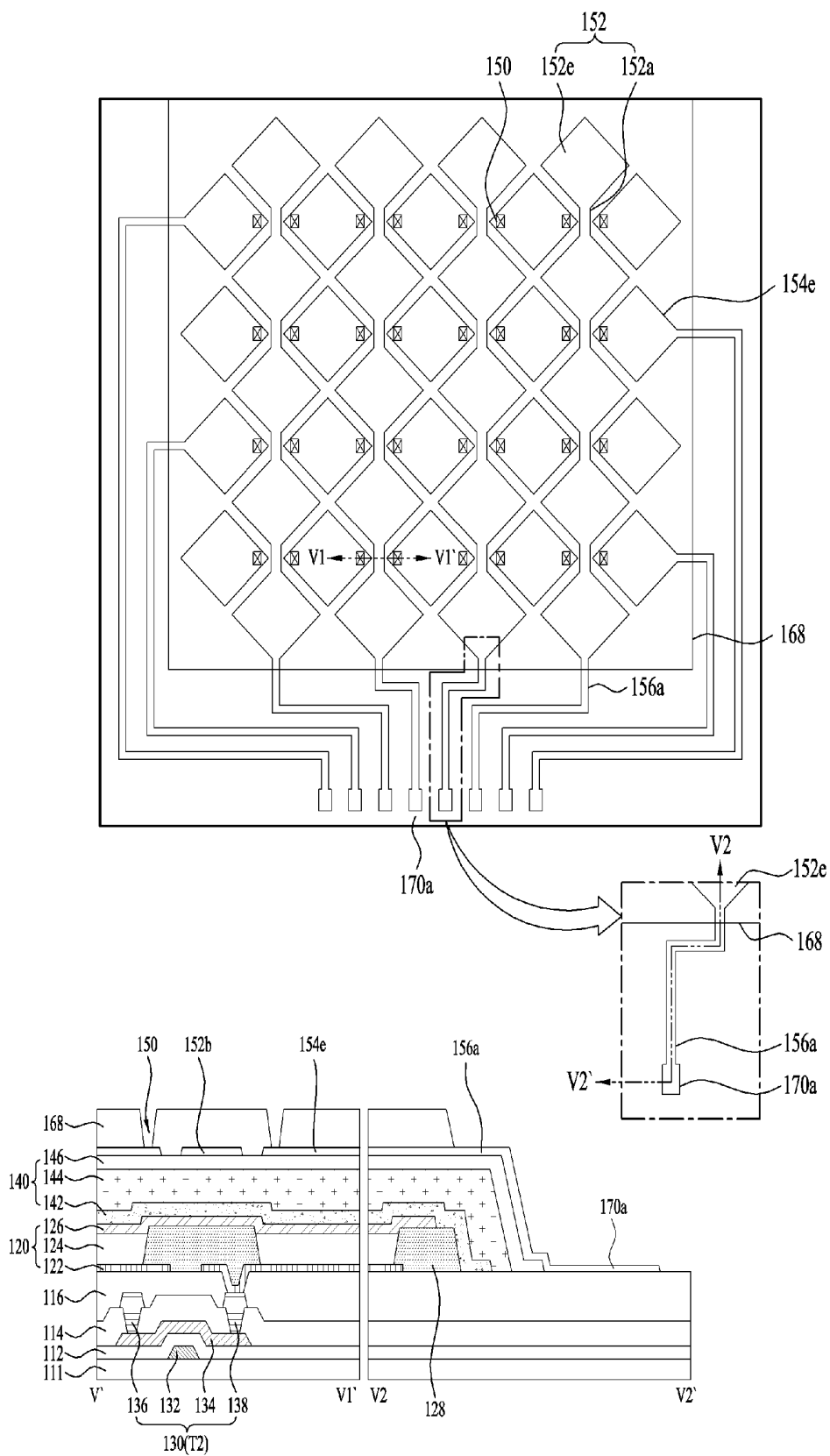


FIG.17C

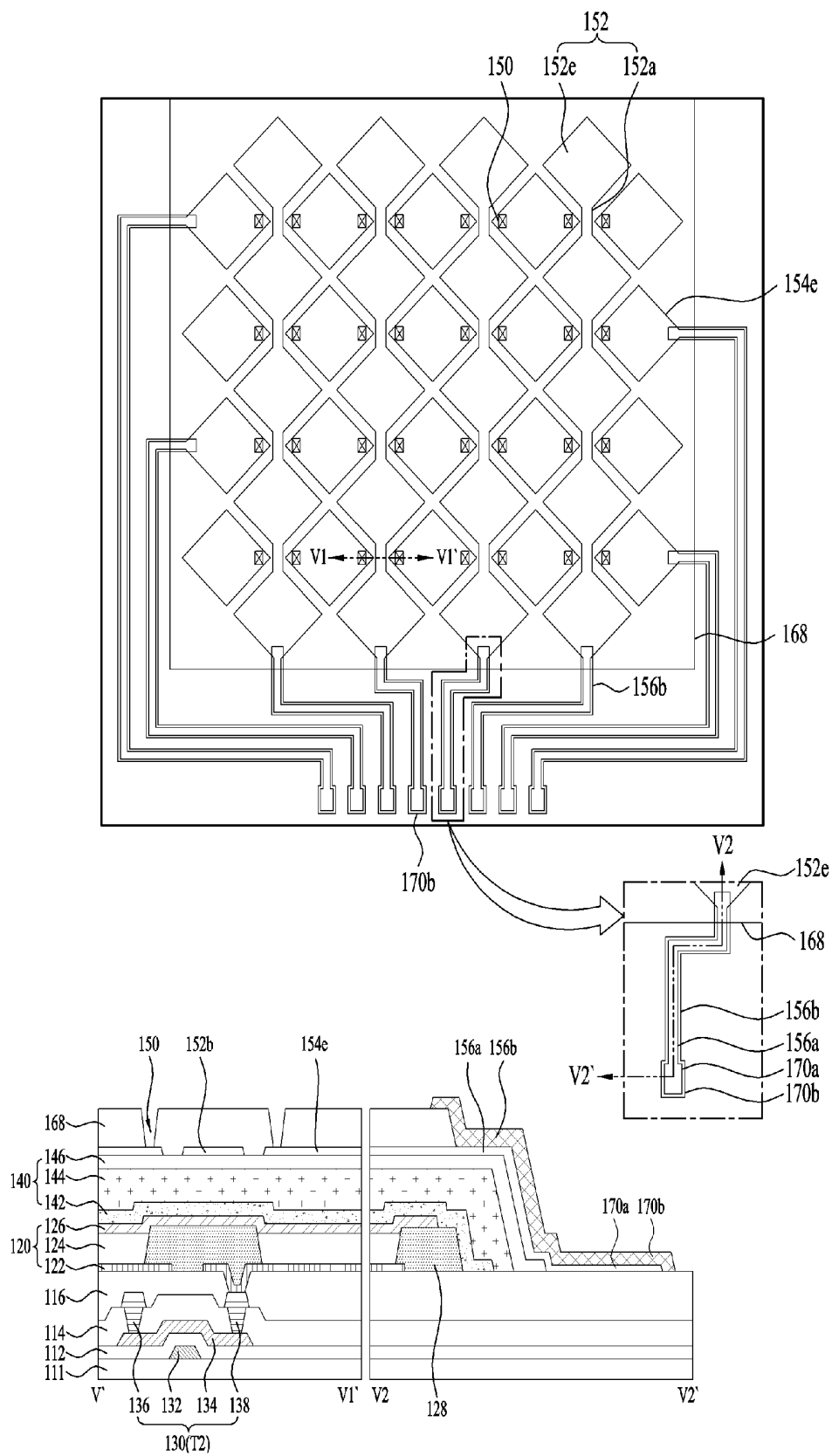


FIG.17D

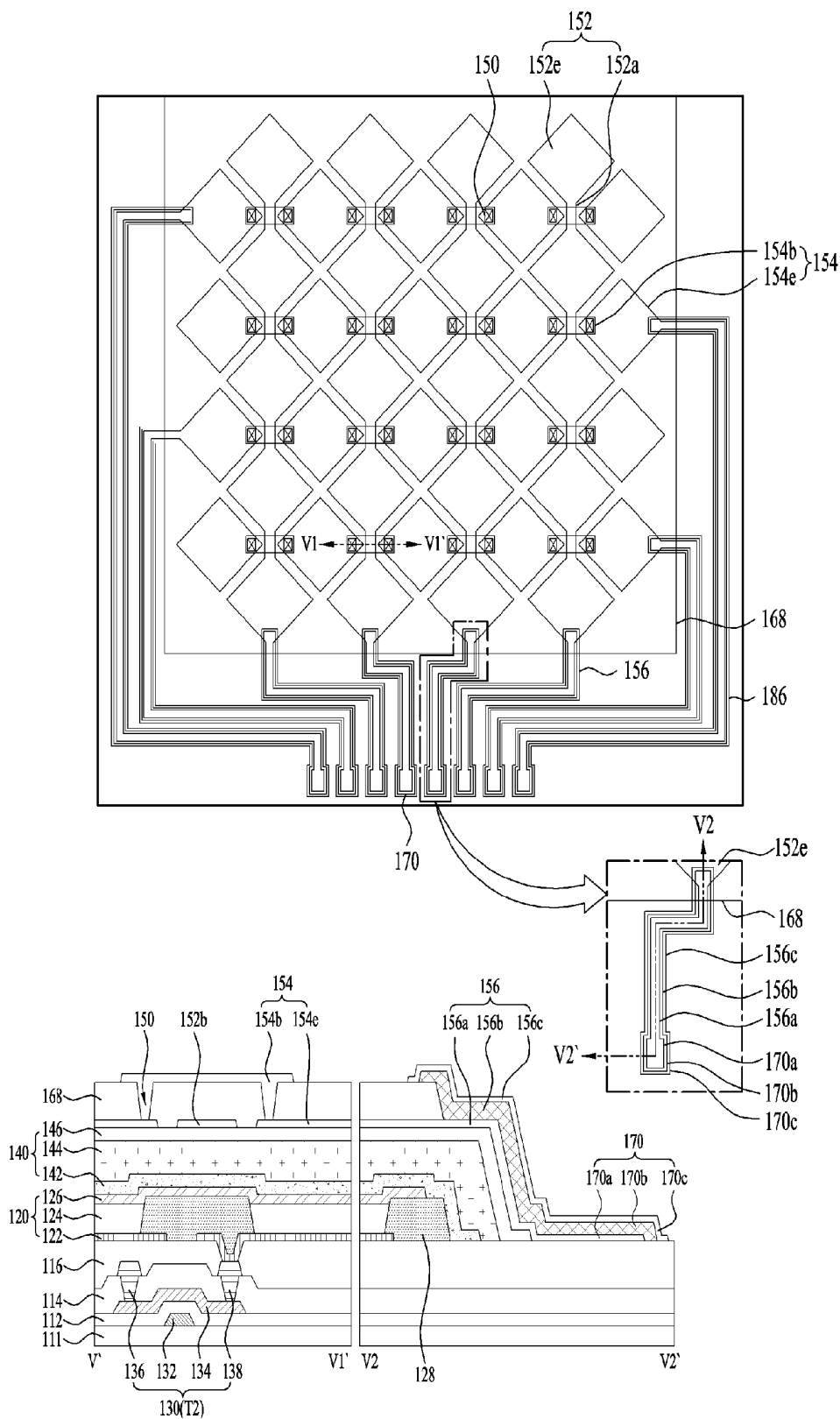


FIG.17E

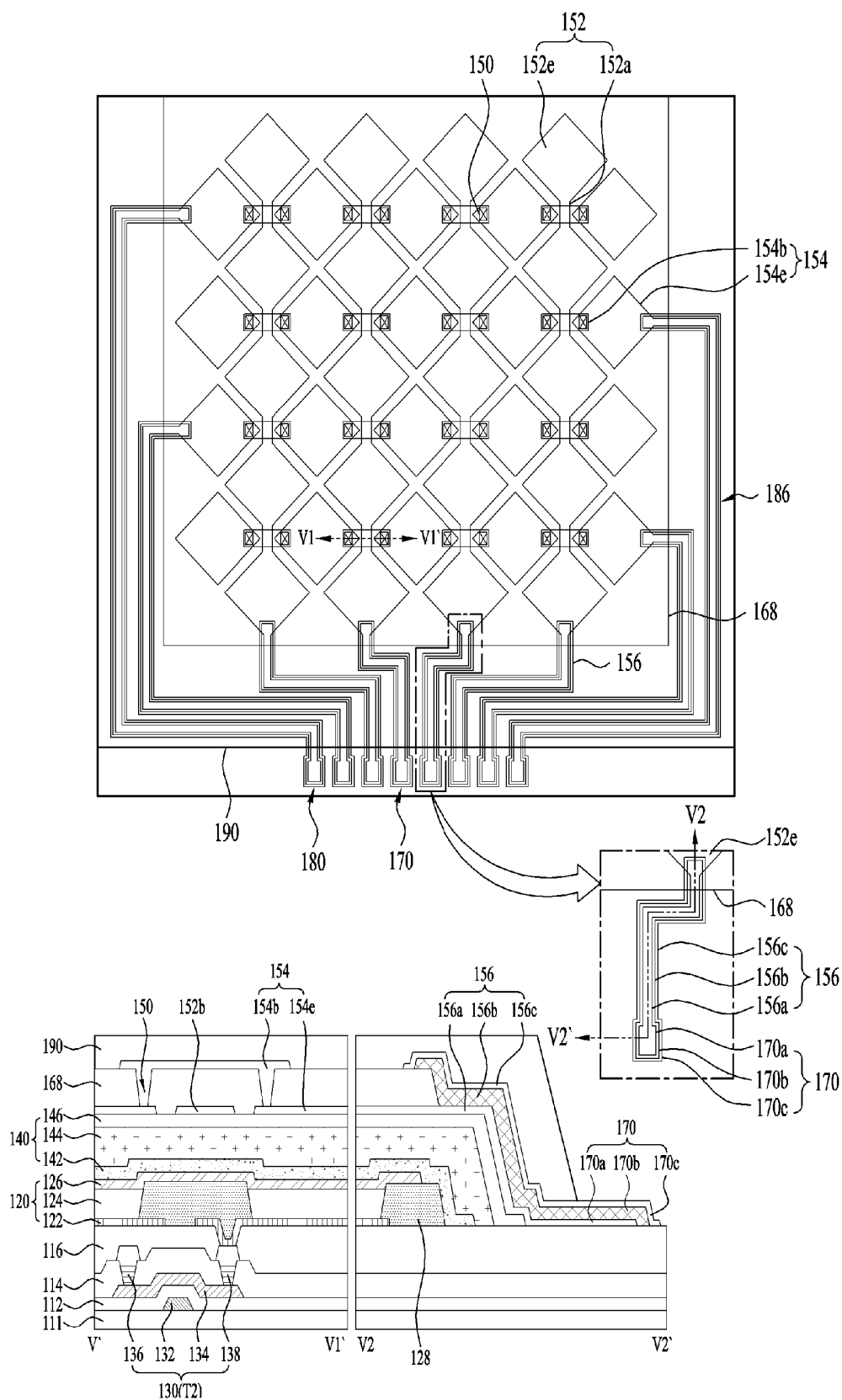
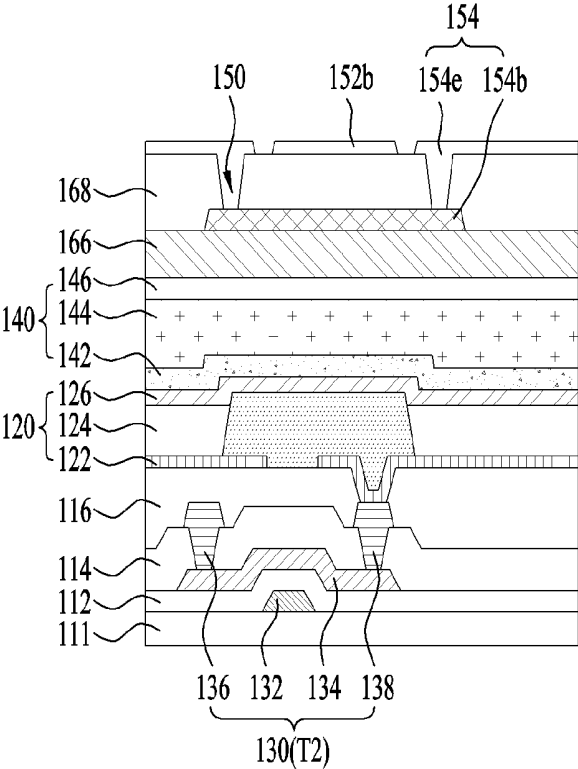


FIG.18



**ORGANIC LIGHT EMITTING DISPLAY
HAVING TOUCH SENSORS AND METHOD
OF FABRICATING THE SAME, AND
DISPLAY DEVICE**

CROSS-REFERENCE TO RELATED
APPLICATIONS

[0001] This application claims the benefit of Korean Patent Application No. 10-2016-0112192, filed on Aug. 31, 2016, which is hereby incorporated by reference as if fully set forth herein.

BACKGROUND

Field of Technology

[0002] The present disclosure relates to an organic light emitting display having touch sensors and a method of fabricating the same and a display device, and more particularly, to an organic light emitting display having touch sensors which may achieve process simplification and cost reduction, and a method of fabricating the same and a display device.

Discussion of the Related Art

[0003] A touchscreen is an input device through which a user may input a command by selecting instructions displayed on a screen of a display using a hand or an object. That is, the touchscreen converts a contact position directly contacting a human hand or an object into an electrical signal and receives instructions selected at the contact position as an input signal. Such a touchscreen may substitute for a separate input device connected to a display and operated, such as a keyboard or a mouse, and thus applications of the touchscreen have gradually increased.

[0004] In general, a touchscreen is attached to the front surface of a display panel, such as a liquid crystal display panel or an organic electroluminescent display panel, by an adhesive. In this case, since the touchscreen is separately manufactured and then attached to the front surface of the display panel, an attachment process is additionally carried out and thus the overall fabrication process becomes complicated and manufacturing costs are raised.

SUMMARY

[0005] Accordingly, the present disclosure is directed to an organic light emitting display having touch sensors and a method of fabricating the same that substantially obviate one or more problems due to limitations and disadvantages of the related art.

[0006] An object of the present disclosure is to provide an organic light emitting display having touch sensors which may achieve process simplification and cost reduction, and a method of fabricating the same.

[0007] Additional advantages, objects, and features of the invention will be set forth in part in the description which follows and in part will become apparent to those having ordinary skill in the art upon examination of the following or may be learned from practice of the invention. The objectives and other advantages of the invention may be realized and attained by the structure particularly pointed out in the written description and claims hereof as well as the appended drawings.

[0008] To achieve these objects and other advantages and in accordance with the purpose of the invention, as embodied and broadly described herein, an organic light emitting display includes a light emitting device disposed in an active area of a substrate that displays images, an encapsulation part disposed on the light emitting device, the encapsulation part including a plurality of inorganic encapsulation layers and at least one organic encapsulation layer, a plurality of touch sensing lines and a plurality of touch driving lines disposed on the encapsulation part, the plurality of touch sensing lines and the plurality of touch driving lines intersecting each other in the active area, and the plurality of touch driving lines and the plurality of touch sensing lines each including a plurality of conductive layers arranged in a stacking sequence, a plurality of routing lines connected to the plurality of touch sensing lines and the plurality of touch driving lines, each of the plurality of routing lines including a plurality of routing layers, each of the plurality of routing layers made of a same material as a corresponding one of the plurality of conductive layers and the plurality of routing layers in a same stacking sequence as the stacking sequence of the plurality of conductive layers.

[0009] A method of fabricating an organic light emitting display comprises: forming a light emitting device disposed in an active area of a substrate that displays images; forming an encapsulation part including a plurality of inorganic encapsulation layers and at least one organic encapsulation layer on the light emitting device; and forming a plurality of touch sensing lines, a plurality of touch driving lines, and a plurality of routing lines on the encapsulation part, wherein the plurality of touch sensing lines and the plurality of touch driving lines intersect each other in the active area, and the plurality of touch driving lines and the plurality of touch sensing lines each include a plurality of conductive layers arranged in a stacking sequence; and wherein each of the plurality of routing lines include a plurality of routing layers, each of the plurality of routing layers made of a same material as a corresponding one of the plurality of conductive layers and the plurality of routing layers in a same stacking sequence as the stacking sequence of the plurality of conductive layers.

[0010] In one embodiment, a display device comprises: a substrate comprising an active region that displays images and a non-active region that does not display images; a light emitting device that emits light in the active area of the substrate; a touch sensor in the active area of the substrate that senses touch of the display device, the touch sensor over the light emitting device and including a plurality of conductive layers, the plurality of conductive layers arranged in a stacking sequence; and a plurality of routing lines in the non-active region of the substrate that are connected to the touch sensor, each of the plurality of routing lines including a plurality of routing layers, each of the plurality of routing layers made of a same material as a corresponding one of the plurality of conductive layers included in the touch sensor, and the plurality of routing layers arranged in a same stacking sequence as the stacking sequence of the plurality of conductive layers of the touch sensor.

[0011] It is to be understood that both the foregoing general description and the following detailed description of the present invention are exemplary and explanatory and are intended to provide further explanation of the invention as claimed.

BRIEF DESCRIPTION OF THE DRAWINGS

[0012] The accompanying drawings, which are included to provide a further understanding of the invention and are incorporated in and constitute a part of this application, illustrate embodiment(s) of the invention and together with the description serve to explain the principle of the invention. In the drawings:

[0013] FIG. 1 is a perspective view of an organic light emitting display having touch sensors in accordance with one embodiment of the present disclosure;

[0014] FIG. 2 is a plan view of the organic light emitting display shown in FIG. 1 in accordance with one embodiment of the present disclosure;

[0015] FIG. 3 is a cross-sectional view of the organic light emitting display, taken along lines I1-I1' and I2-I2' of FIG. 2 in accordance with one embodiment of the present disclosure;

[0016] FIGS. 4A to 4C are cross-sectional views illustrating routing lines shown in FIG. 3 in accordance with different embodiments;

[0017] FIGS. 5A to 5D are views illustrating a method of fabricating an organic light emitting display having touch sensors in accordance with one embodiment of the present disclosure;

[0018] FIG. 6 is a plan view of an organic light emitting display having touch sensors in accordance with a further embodiment of the present disclosure;

[0019] FIG. 7 is a cross-sectional view of the organic light emitting display, taken along lines II1-II1' and II2-II2' of FIG. 6 in accordance with one embodiment of the present disclosure;

[0020] FIGS. 8A and 8B are cross-sectional views illustrating routing lines shown in FIG. 7 in accordance with different embodiments;

[0021] FIGS. 9A to 9D are views illustrating a method of fabricating an organic light emitting display having touch sensors in accordance with a further embodiment of the present disclosure;

[0022] FIG. 10 illustrates plan and cross-sectional views of an organic light emitting display having touch sensors in accordance with another embodiment of the present disclosure;

[0023] FIGS. 11A to 11E are views illustrating a method of fabricating an organic light emitting display having touch sensors in accordance with another embodiment of the present disclosure;

[0024] FIG. 12 illustrates plan and cross-sectional views of an organic light emitting display having touch sensors in accordance with another embodiment of the present disclosure;

[0025] FIGS. 13A to 13C are cross-sectional views illustrating routing lines shown in FIG. 12 in accordance with one embodiment of the present disclosure;

[0026] FIGS. 14A to 14D are views illustrating a method of fabricating an organic light emitting display having touch sensors in accordance with another embodiment of the present disclosure;

[0027] FIG. 15 illustrates plan and cross-sectional views of an organic light emitting display having touch sensors in accordance with yet another embodiment of the present disclosure;

[0028] FIGS. 16A to 16D are cross-sectional views illustrating routing lines shown in FIG. 15 in accordance with different embodiments;

[0029] FIGS. 17A to 17E are views illustrating a method of fabricating an organic light emitting display having touch sensors in accordance with yet another embodiment of the present disclosure;

[0030] FIG. 18 is a cross-sectional view of an organic light emitting display having a touch buffer film in accordance with the present disclosure; and

[0031] FIG. 19 is a view illustrating first and second touch electrodes of an organic light emitting display in accordance with another embodiment.

DETAILED DESCRIPTION

[0032] Reference will now be made in detail to the embodiments of the present invention, examples of which are illustrated in the accompanying drawings. Wherever possible, the same reference numbers will be used throughout the drawings to refer to the same or like parts.

[0033] FIG. 1 is a perspective view of an organic light emitting display having touch sensors in accordance with one embodiment of the present disclosure.

[0034] An organic light emitting display having touch sensors shown in FIG. 1 senses whether or not a user touch occurs and a touch position by sensing a change of mutual capacitance C_m caused by the user touch through touch electrodes $152e$ and $154e$ shown in FIG. 2 for a period of touch time. Further, the organic light emitting display shown in FIG. 1 displays an image through unit pixels including light emitting devices 120 . The unit pixel includes red (R), green (G) and blue (B) sub-pixels PXL, or includes red (R), green (G), blue (B) and white (W) sub-pixels PXL.

[0035] Each sub-pixel PXL includes a pixel drive circuit and a light emitting device 120 connected to the pixel drive circuit.

[0036] The pixel drive circuit includes a switching transistor $T1$, a driving transistor $T2$, and a storage capacitor C_{st} .

[0037] The switching transistor $T1$ is turned on, when a scan pulse is supplied to a scan line SL , and supplies a data signal, supplied to a data line DL , to the storage capacitor C_{st} and a gate electrode of the driving transistor $T2$.

[0038] The driving transistor $T2$ controls current I supplied to the light emitting device 120 from a high voltage (VDD) line 161 , thus adjusting a light emission amount of the light emitting device 120 . Further, even if the switching transistor $T1$ is turned off, the driving transistor $T2$ supplies designated current I by voltage charging the storage capacitor C_{st} until a data signal of the next frame is supplied and, thus, light emission by the light emitting device 120 is maintained.

[0039] Such a driving thin film transistor $T2(130)$ includes, as exemplarily shown in FIG. 3, a gate electrode 132 , a semiconductor layer 134 overlapping the gate electrode 132 with a gate insulating film 112 interposed therebetween, and source and drain electrodes 136 and 138 formed on a passivation film 114 and contacting the semiconductor layer 134 .

[0040] The light emitting device 120 is disposed in an active area of a substrate 111 and includes an anode 122 , an organic light emitting layer 124 formed on the anode 122 , and a cathode 126 formed on the organic light emitting layer 124 .

[0041] The anode 122 is conductively connected to the drain electrode 138 of the driving thin film transistor 130 exposed through a pixel contact hole formed through a planarization film 116 . The organic light emitting layer 124

is formed on the anode 122 in an emission region provided by a bank 128. The organic light emitting layer 124 is formed by stacking a hole-related layer, a light emitting layer and an electron-related layer on the anode 122 in regular order or in reverse order. The cathode 126 is formed opposite the anode 122 with the organic light emitting layer 124 interposed therebetween.

[0042] An encapsulation part 140 prevents external moisture or oxygen from permeating the light emitting device 120, which is vulnerable to external moisture or oxygen. For this purpose, the encapsulation part 140 includes a plurality of inorganic encapsulation layers 142 and 146 and an organic encapsulation layer 144 disposed between the inorganic encapsulation layers 142 and 146, and the inorganic encapsulation layer 146 is disposed as the uppermost layer. Here, the encapsulation part 140 includes at least two inorganic encapsulation layers 142 and 146 and at least one organic encapsulation layer 144. In the present disclosure, the structure of the encapsulation part 140 in which the organic encapsulation layer 144 is disposed between the first and second inorganic encapsulation layers 142 and 146 will be exemplarily illustrated.

[0043] The first inorganic encapsulation layer 142 is formed on the substrate 111 provided with the cathode 126 so as to be located most adjacent to the light emitting device 120. Such a first inorganic encapsulation layer 142 is formed of an inorganic insulating material which may be deposited at a low temperature, such as silicon nitride (SiN_x), silicon oxide (SiO_x), silicon oxynitride (SION) or aluminum oxide (Al_2O_3). Therefore, the first inorganic encapsulation layer 142 is deposited in a low-temperature atmosphere and, thus, during a deposition process of the first inorganic encapsulation layer 142, damage to the organic light emitting layer 124, which is vulnerable to a high-temperature atmosphere, may be prevented.

[0044] The organic encapsulation layer 144 serves as a buffer to damp stress between respective layers according to bending of the organic light emitting display and strengthens planarization performance of the organic light emitting display. The organic encapsulation layer 144 is formed of an organic insulating material, such as acrylic resin, epoxy resin, polyimide, polyethylene or silicon oxycarbide (SiOC).

[0045] The second inorganic encapsulation layer 146 is formed on the substrate 111 provided with the organic encapsulation layer 144 formed thereon so as to cover the upper and side surfaces of the organic encapsulation layer 144 and the first inorganic encapsulation layer 142. Therefore, the second inorganic encapsulation layer 146 minimizes or blocks penetration of external moisture or oxygen into the first inorganic encapsulation layer 142 and the organic encapsulation layer 144. Such a second inorganic encapsulation layer 146 is formed of an inorganic insulating material, such as silicon nitride (SiN_x), silicon oxide (SiO_x), silicon oxynitride (SION) or aluminum oxide (Al_2O_3).

[0046] Touch sensing lines 154 and touch driving lines 152 are disposed on the encapsulation part 140 so as to intersect each other with a touch insulating film 168 interposed therebetween, as exemplarily shown in FIGS. 2 and 3.

[0047] The touch driving line 152 includes a plurality of first touch electrodes 152e and first bridges 152b conductively connecting the first touch electrodes 152e.

[0048] The first touch electrodes 152e are spaced apart from each other by designated intervals in the Y direction on the encapsulation part 140. Each of the first touch electrodes

152e is conductively connected to the adjacent first touch electrode 152e through the first bridge 152b.

[0049] The first bridges 152b are disposed on the encapsulation part 140 coplanar with the first touch electrodes 152e and are conductively connected to the first touch electrodes 152e without separate contact holes. The first bridges 152b are disposed so as to overlap the bank 128 and thus reduction of an aperture ratio by the first bridges 152b may be prevented.

[0050] If the first bridges 152b and the first touch electrodes 152e are formed of a transparent conductive film, auxiliary bridges 152a directly contacting the first bridges 152b are formed under the first bridges 152b. The auxiliary bridges 152a are formed of a first conductive layer having a monolayer structure or a multilayer structure using at least one of materials having high conductivity, such as Al, Ti, Cu, Mo and MoTi, and compensate for resistances of the first bridges 152b and the first touch electrodes 152e, formed of a second conductive layer, i.e., a transparent conductive film.

[0051] The touch sensing line 154 includes a plurality of second touch electrodes 154e and second bridges 154b conductively connecting the second touch electrodes 154e.

[0052] The second touch electrodes 154e are spaced apart from each other by designated intervals in the X direction on the encapsulation part 140. Each of the second touch electrodes 154e is conductively connected to the adjacent second touch electrode 154e through the second bridge 154b.

[0053] The second bridges 154b are disposed on the touch insulating film 168 and are conductively connected to the second touch electrodes 154e exposed through touch contact holes 150 formed through the touch insulating film 168. The second bridges 154b are disposed so as to overlap the bank 128 in the same manner as the first bridges 152b and thus reduction of the aperture ratio by the second bridges 154b may be prevented.

[0054] Since the touch sensing lines 154 intersect the touch driving lines 152 with the touch insulating film 168 interposed therebetween, as described above, mutual capacitances C_m are formed at the intersections between the touch sensing lines 154 and the touch driving lines 152. The mutual capacitances C_m are electrically charged by touch driving pulses supplied to the touch driving lines 152 and discharge to the touch sensing lines 154, thus serving as touch sensors.

[0055] The touch driving lines 152 of the present disclosure are connected to a touch driving unit (not shown) through first routing lines 156 and touch driving pads 170, disposed in an inactive (bezel) area. Thereby, the first routing line 156 transmits a touch driving pulse from the touch driving pad 170 to the touch driving line 152. Further, the touch sensing lines 154 are connected to the touch driving unit through second routing lines 186 and touch sensing pads 180, disposed in the inactive (bezel) area. Thereby, the second routing line 186 transmits a touch signal from the touch sensing line 154 to the touch sensing pad 180.

[0056] Each of the touch driving pads 170 and the touch sensing pads 180 is formed to have a tri-layer structure, formed, for example, by sequentially stacking first to third pad layers 170a, 170b and 170c using first to third conductive layers.

[0057] Each of the first and second routing lines 156 and 186 is formed to have a multilayer structure, for example, formed by sequentially stacking first to third routing layers

156a, 156b and 156c. Here, the first to third routing layers 156a, 156b and 156c are stacked so as to correspond to a stacking sequence and materials of a plurality of conductive layers disposed on the encapsulation part 140 in the active area.

[0058] That is, the auxiliary bridges 152a formed of a first opaque conductive layer, the first bridges 152b formed of a second transparent conductive layer, and the second bridges 154b formed of a third transparent conductive layer are sequentially stacked on the encapsulation part 140 in the active area. Therefore, each of the first and second routing lines 156 and 186 is formed by sequentially stacking the first routing layer 156a formed of the first opaque conductive layer, the second routing layer 156b formed of the second transparent conductive layer, and the third routing layer 156c formed of the third transparent conductive layer so as to correspond to the stacking sequence of the conductive layers on the encapsulation part 140 in the active area.

[0059] Here, the first routing layer 156a is formed of a first conductive layer having a monolayer structure or a multilayer structure using Al, Ti, Cu, Mo, MoTi. The second routing layer 156b extends from each of the first and second touch electrodes 152e and 154e and is formed of a second conductive layer including a transparent conductive film, such as ITO, IZO, ZnO, IGZO or ITO/Ag/ITO, or a conductive polymer. The third routing layer 156c is formed of a third conductive layer including a transparent conductive film, such as ITO, IZO, ZnO, IGZO or ITO/Ag/ITO, or a conductive polymer.

[0060] If the second routing layer 156b and the third routing layer 156c are formed of the same material, the third routing layer 156c may be formed on the second routing layer 156b to have the same line width as that of the second routing layer 156b, as exemplarily shown in FIGS. 4A and 4B, or, the third routing layer 156c may be formed on the second routing layer 156b to have a greater line width than that of the second routing layer 156b so as to cover the side and upper surfaces of the second routing layer 156b, as exemplarily shown in FIG. 4C. Therefore, etching of the second routing layer 156b formed of the same material as the third routing layer 156c by an etching solution or etching gas used in formation of the third routing layer 156c may be prevented. Further, the side surface of the third routing layer 156c adjacent to each of the first and second touch electrodes 152e and 154e is disposed on the touch insulating film 168. Therefore, the touch insulating film 168 protects the second routing layer 156b during formation of the third routing layer 156c, thus preventing etching of the second routing layer 156b formed of the same material as the third routing layer 156c.

[0061] Further, if etching characteristics (for example, etching gases or etching solutions) of materials of the first and second routing layers 156a and 156b are the same, the second routing layer 156b is formed on the first routing layer 156a to have a greater line width than that of the first routing layer 156a so as to cover the side and upper surfaces of the first routing layer 156a, as exemplarily shown in FIGS. 4A and 4C. Therefore, etching of the first routing layer 156a having the same material as the second routing layer 156b by an etching solution or etching gas used in formation of the second routing layer 156b may be prevented.

[0062] Further, if etching characteristics of materials of the first and second routing layers 156a and 156b are different, the second routing layer 156b is formed on the first

routing layer 156a to have a line width which is the same as or different from that of the first routing layer 156a. For example, the second routing layer 156b may be formed on the first routing layer 156a to have a narrower line width than that of the first routing layer 156a, as exemplarily shown in FIG. 4B.

[0063] As such, each of the first and second routing lines 156 and 186 is formed to have a multilayer structure and, if a break in any one of a plurality of routing conductive layers included in each of the first and second routing lines 156 and 186 occurs, each of a touch driving pulse and a touch signal is transmitted through the remaining routing conductive layers.

[0064] As described above, the organic light emitting display in accordance with this embodiment of the present disclosure includes the first and second routing lines 156 and 186 formed of a plurality of routing layers, stacked in a stacking sequence of the touch driving lines 152 and the touch sensing lines 154. The first and second routing lines 156 and 186 have a multilayer structure and, thus, a break of the first and second routing lines 156 and 186 may be prevented. Further, while a touchscreen is attached to a conventional organic light emitting display by an adhesive, in the organic light emitting display in accordance with the present disclosure, the touch electrodes 152e and 154e are directly stacked on the encapsulation part 140 without a separate attachment process and thus the overall fabrication process may be simplified and manufacturing costs may be reduced.

[0065] FIGS. 5A to 5D are plan and cross-sectional views illustrating a method of fabricating the organic light emitting display shown in FIGS. 2 and 3 in accordance with one embodiment.

[0066] With reference to FIG. 5A, the auxiliary bridges 152a, the first routing layer 156a of each of the first and second routing lines 156 and 186, and the first pad layer 170a of each of the touch driving pads 170 and the touch sensing pads 180 are formed on the substrate 111 provided with the light emitting devices 120 and the encapsulation part 140 formed thereon.

[0067] In more detail, a first conductive layer is deposited on the whole surface of the substrate 111 provided with the light emitting devices 120 and the encapsulation part 140 formed thereon through a deposition process. Thereafter, the auxiliary bridges 152a, the first routing layer 156a and the first pad layer 170a are formed by patterning the first conductive layer through a photolithography process using a first mask and an etching process. Here, the first conductive layer is formed to have a monolayer structure or a multilayer structure using metals having high corrosion resistance and high acid resistance, such as Al, Ti, Cu, Mo and MoTi. For example, the first conductive layer has a tri-layer structure, such as Ti/Al/Ti or Mo/Al/Mo.

[0068] With reference to FIG. 5B, the first bridges 152b, the first and second touch electrodes 152e and 154e, the second routing layer 156b of each of the first and second routing lines 156 and 186 and the second pad layer 170b of the touch driving pads 170 and the touch sensing pads 180 are formed on the substrate 111 provided with the auxiliary bridges 152a, the first routing layer 156a and the first pad layer 170a formed thereon.

[0069] In more detail, a second conductive layer is deposited on the whole surface of the substrate 111 provided with the auxiliary bridges 152a, the first routing layer 156a and

the first pad layer **170a** formed thereon through a deposition process. Thereafter, the first bridges **152b**, the first and second touch electrodes **152e** and **154e**, the second routing layer **156b** and the second pad layer **170b** are formed by patterning the second conductive layer through a photolithography process using a second mask and an etching process. Here, the second conductive layer employs a transparent conductive film, such as ITO, IZO, ZnO, IGZO or ITO/Ag/ITO, or a conductive polymer.

[0070] With reference to FIG. 5C, the touch insulating film **168** having the touch contact holes **150** is formed on the substrate **111** provided with the first bridges **152b**, the first and second touch electrodes **152e** and **154e**, the second routing layer **156b** and the second pad layer **170b** formed thereon.

[0071] In more detail, an inorganic or organic insulating material is deposited on the substrate **111** provided with the first bridges **152b**, the first and second touch electrodes **152e** and **154e**, the second routing layer **156b** and the second pad layer **170b** formed thereon through a deposition process using a metal mask, thereby forming the touch insulating film **168** to expose the second routing layer **156b** and the second pad layer **170b**. Here, the touch insulating film **168** may be formed by an inorganic film, such as SiN_x , SiON or SiO_2 , silicon oxynitride (or aluminum oxide (Al_2O_3)), an acrylic-based organic film, an epoxy-based organic film, Parylene-C, Parylene-N, Parylene-F or an siloxane-based organic film. Therefore, the touch contact holes **150** are formed by patterning the touch insulating film **168** through a photolithography process using a third mask and an etching process. The touch contact holes **150** are formed through the touch insulating film **168** and thus expose the second touch electrodes **154e**.

[0072] With reference to FIG. 5D, the third routing layer **156c** of each of the first and second routing lines **156** and **186**, the third pad layer **170c** of each of the touch driving pads **170** and the touch sensing pads **180**, and the second bridges **154b** are formed on the substrate **111** provided with the contact hole **150** formed thereon.

[0073] In more detail, a third conductive layer is deposited on the whole surface of the substrate **111** provided with the touch contact holes **150** formed thereon through a deposition process. Thereafter, the third routing layer **156c**, the third pad layer **170c** and the second bridges **154b** are formed by patterning the third conductive layer through a photolithography process using a fourth mask and an etching process. Here, the third conductive layer employs a transparent conductive film, such as ITO, IZO, ZnO, IGZO or ITO/Ag/ITO, or a conductive polymer.

[0074] As described above, in this embodiment of the present disclosure, the conductive layers on the encapsulation part **140** form a tri-layer structure and the routing layers included in the routing lines **156** and **186** form a tri-layer structure. In this case, the first to third routing layers **156a**, **156b** and **156c** are respectively formed simultaneously with the first to third conductive layers having the same layer numbers. That is, the auxiliary bridges **152a** and the first routing layer **156a** formed of the first conductive layer located at a lower layer are simultaneously formed, the first bridges **152b** and the second routing layer **156b** formed of the second conductive layer located at a middle layer are simultaneously formed, and the second bridges **154b** and the third routing layers **156c** formed of the third conductive layer located at an upper layer are simultaneously formed.

[0075] FIG. 6 is a plan view of an organic light emitting display having touch sensors in accordance with a further embodiment of the present disclosure, and FIG. 7 is a cross-sectional view of the organic light emitting display, taken along lines III-III' and II2-II2' of FIG. 6.

[0076] The organic light emitting display shown in FIGS. 6 and 7 is the same as the organic light emitting display shown in FIGS. 2 and 3, except that each of first and second routing lines **156** and **186** is formed by sequentially stacking a first routing layer **156a**, i.e., an opaque conductive layer, and a second routing layer **156b**, i.e., a transparent conductive layer, and first bridges **152b** formed of a transparent conductive layer are stacked on second bridges **154b** formed of an opaque conductive layer so as to correspond to the stacking sequence of the first and second routing layers **156a** and **156b**. Therefore, a detailed description of elements of the organic light emitting display shown in FIGS. 6 and 7, which are substantially the same as those of the organic light emitting display shown in FIGS. 2 and 3, will be omitted because it is considered to be unnecessary.

[0077] The second bridges **154b** are formed of a first opaque conductive layer on a second inorganic encapsulation layer **146**. The second bridges **154b** are exposed through touch contact holes **150** formed through a touch insulating film **168** and are conductively connected to second touch electrodes **154e**.

[0078] The first and second touch electrodes **152e** and **154e** and the first bridges **152b** are formed of a second transparent conductive layer on the touch insulating film **168** located at a higher position than the encapsulation part **140**.

[0079] Each of the first and second routing lines **156** and **186** is formed by sequentially stacking the first routing layer **156a** formed of the first opaque conductive layer and the second routing layer **156b** formed of the second transparent conductive layer in the same sequence as the stacking sequence of the first and second conductive layers forming the touch driving lines **152** and the touch sensing lines **154**.

[0080] Here, the first routing layer **156a** is formed of the first opaque conductive layer having a monolayer structure or a multilayer structure using Al, Ti, Cu, Mo and MoTi. The second routing layer **156b** extends from each of the first and second touch electrodes **152e** and **154e** and is formed of the second conductive layer including a transparent conductive film, such as ITO, IZO, ZnO, IGZO or ITO/Ag/ITO, or a conductive polymer.

[0081] If etching characteristics of materials of the first and second routing layers **156a** and **156b** are the same, the second routing layer **156b** is formed on the first routing layer **156a** to have a greater line width than that of the first routing layer **156a** so as to cover the side and upper surfaces of the first routing layer **156a**, as exemplarily shown in FIG. 8A. Therefore, etching of the first routing layer **156a** having the same material as the second routing layer **156b** by an etching solution or etching gas used in formation of the second routing layer **156b** may be prevented.

[0082] Further, if etching characteristics of materials of the first and second routing layers **156a** and **156b** are different, the second routing layer **156b** is formed on the first routing layer **156a** to have a line width which is the same as or different from that of the first routing layer **156a**. For example, the second routing layer **156b** may be formed on the first routing layer **156a** to have a narrower line width than that of the first routing layer **156a**, as exemplarily shown in FIG. 8B.

[0083] As such, each of the first and second routing lines 156 and 186 is formed to have a multilayer structure and, if a break in any one of a plurality of routing conductive layers included in each of the first and second routing lines 156 and 186 occurs, each of a touch driving pulse and a touch signal is transmitted through the remaining routing conductive layers.

[0084] Each of the touch driving pads 170 and the touch sensing pads 180 is formed to have a double-layer structure in the same manner as the first and second routing lines 156 and 186. That is, each of the touch driving pads 170 and the touch sensing pads 180 has a double-layer structure acquired by stacking the first and second pad layers 170a and 170b using the first and second conductive layers. The touch driving pads 170 and touch sensing pads 180 are exposed from a touch protective film 190 and thus contact a signal transmission film on which the touch driving unit is mounted. Here, the touch protective film 190 is formed to cover the touch sensing lines 154 and the touch driving lines 152, thus preventing corrosion of the touch sensing lines 154 and the touch driving lines 152 due to external moisture, etc. Such a touch protective film 190 is formed of an organic insulating material or is formed as a circularly polarizing plate or as an epoxy or acrylic film.

[0085] As described above, the organic light emitting display in accordance with this embodiment of the present disclosure includes the first and second routing lines 156 and 186 formed of a plurality of routing layers, stacked in a stacking sequence of the first and second conductive layers included in the touch driving lines 152 and the touch sensing lines 154. The first and second routing lines 156 and 186 have a multilayer structure and, thus, a break of the first and second routing lines 156 and 186 may be prevented. Further, while a touchscreen is attached to a conventional organic light emitting display by an adhesive, in the organic light emitting display in accordance with the present disclosure, the touch electrodes 152e and 154e are directly stacked on the encapsulation part 140 without a separate attachment process and thus the overall fabrication process may be simplified and manufacturing costs may be reduced.

[0086] FIGS. 9A to 9D are plan and cross-sectional views illustrating a method of fabricating the organic light emitting display shown in FIGS. 6 and 7.

[0087] First, a first conductive layer is deposited on the whole surface of the encapsulation part 140 through a deposition process and, then, the first conductive layer is patterned through a photolithography process using a first mask and an etching process. Thereby, the second bridges 154b, the first routing layer 156a of each of the first and second routing lines 156 and 186 and the first pad layer 170a of each of the touch driving pads 170 and the touch sensing pads 180 are formed on the encapsulation part 140, as exemplarily shown in FIG. 9A. Here, the first conductive layer is formed to have a monolayer structure or a multilayer structure using metals having high corrosion resistance and high acid resistance, such as Al, Ti, Cu, Mo and MoTi. For example, the first conductive layer has a tri-layer structure, such as Ti/Al/Ti or Mo/Al/Mo.

[0088] Thereafter, the touch insulating film 168 to expose the second routing layer 156b and the second pad layer 170b is formed by depositing an inorganic or organic insulating material on the substrate 111, provided with the second bridges 154b, the first routing layer 156a and the first pad layer 170a formed thereon, through a deposition process

using a metal mask. Thereafter, the touch contact holes 150 are formed by patterning the touch insulating film 168 through a photolithography process using a second mask and an etching process, as exemplarily shown in FIG. 9B.

[0089] Thereafter, a second conductive layer is deposited on the whole surface of the substrate 111 provided with the touch insulating film 168 having the touch contact holes 150 formed thereon through a deposition process and, then, the second conductive layer is patterned through a photolithography process using a third mask and an etching process. Thereby, the first bridges 152b, the first and second touch electrodes 152e and 154e, the second routing layer 156b of each of the first and second routing lines 156 and 186, and the second pad layer 170b of each of the touch driving pads 170 and the touch sensing pads 180 are formed on the touch insulating film 168, as exemplarily shown in FIG. 9C. Here, the second conductive layer employs a transparent conductive film, such as ITO, IZO, ZnO, IGZO or ITO/Ag/ITO, or a conductive polymer.

[0090] Thereafter, an organic insulating material is applied to the whole surface of the substrate 111 provided with the first bridges 152b, the first and second touch electrodes 152e and 154e, the second routing layer 156b and the second pad layer 170b formed thereon and, then, the organic insulating material is patterned through a photolithography process using a fourth mask and an etching process. Thereby, the touch protective film 190 to expose the second pad layer 170b of each of the touch driving pads 170 and the touch sensing pads 180 is formed, as exemplarily shown in FIG. 9D.

[0091] As described above, in this embodiment of the present disclosure, the second bridges 154b and the first routing layer 156a formed of the first conductive layer located at a lower layer are simultaneously formed, and the first bridges 152b and the second routing layer 156b formed of the second conductive layer located at an upper layer are simultaneously formed.

[0092] FIG. 10 illustrates plan and cross-sectional views of an organic light emitting display having touch sensors in accordance with another embodiment of the present disclosure.

[0093] The organic light emitting display shown in FIG. 10 is the same as the organic light emitting display shown in FIGS. 2 and 3, except that each of first and second routing lines 156 and 186 is formed by sequentially stacking a first routing layer 156a, i.e., an opaque conductive layer, a second routing layer 156b, i.e., a transparent conductive layer, and a third routing layer 156c, i.e., a transparent conductive layer, and first bridges 152b formed of a third transparent conductive layer are stacked on second bridges 154b formed of a second transparent conductive layer so as to correspond to the stacking sequence of the second and third routing layers 156b and 156c. Therefore, a detailed description of elements of the organic light emitting display shown in FIG. 10, which are substantially the same as those of the organic light emitting display shown in FIGS. 2 and 3, will be omitted because it is considered to be unnecessary.

[0094] The second bridges 154b are formed of the second transparent conductive layer on an inorganic encapsulation layer 146. The second bridges 154b are exposed through touch contact holes 150 formed through a touch insulating film 168 and are conductively connected to second touch electrodes 154e. The first and second touch electrodes 152e and 154e and the first bridges 152b are formed of the third

transparent conductive layer on the touch insulating film **168** located at a higher position than the encapsulation part **140**. The first and second bridges **152b** and **154b** are formed of transparent conductive layers and may thus improve light transmittance.

[0095] The second and third transparent routing layers **156b** and **156c** included in each of the first and second routing lines **156** and **186** are stacked so as to correspond to the stacking sequence of the second and third transparent conductive layers forming the touch driving lines **152** and the touch sensing lines **154**. That is, each of the first and second routing lines **156** and **186** is formed by sequentially stacking the first routing layer **156a** formed of the first opaque conductive layer, the second routing layer **156b** formed of the second transparent conductive layer, and the third routing layer **156c** formed of the third transparent conductive layer.

[0096] Here, the first routing layer **156a** is formed of the first opaque conductive layer having a monolayer structure or a multilayer structure using Al, Ti, Cu, Mo and MoTi. The second routing layer **156b** is formed of the second conductive layer including a transparent conductive film, such as ITO, IZO, ZnO, IGZO or ITO/Ag/ITO, or a conductive polymer. The third routing layer **156c** extends from each of the first and second touch electrodes **152e** and **154e** and is formed of the third conductive layer including a transparent conductive film, such as ITO, IZO, ZnO, IGZO or ITO/Ag/ITO, or a conductive polymer.

[0097] The laminated cross-section of the first and second routing lines **156** and **186** are the same as those shown in FIGS. 4A to 4C and a detailed description thereof will thus be omitted.

[0098] As such, each of the first and second routing lines **156** and **186** is formed to have a multilayer structure and, if a break in any one of a plurality of routing conductive layers included in each of the first and second routing lines **156** and **186** occurs, each of a touch driving pulse and a touch signal is transmitted through the remaining routing conductive layers.

[0099] Each of the touch driving pads **170** and the touch sensing pads **180** is formed to have a tri-layer structure in the same manner as the first and second routing lines **156** and **186**. That is, each of the touch driving pads **170** and the touch sensing pads **180** has a tri-layer structure acquired by stacking the first to third pad layers **170a**, **170b** and **170c** using the first to third conductive layers.

[0100] As described above, the organic light emitting display in accordance with this embodiment of the present disclosure includes the first and second routing lines **156** and **186** having a multilayer structure, thus preventing a break of the first and second routing lines **156** and **186**. Further, while a touchscreen is attached to a conventional organic light emitting display by an adhesive, in the organic light emitting display in accordance with the present disclosure, the touch electrodes **152e** and **154e** are directly stacked on the encapsulation part **140** without a separate attachment process and thus the overall fabrication process may be simplified and manufacturing costs may be reduced.

[0101] FIGS. 11A to 11E are plan and cross-sectional views illustrating a method of fabricating the organic light emitting display shown in FIG. 10.

[0102] First, a first conductive layer is deposited on the whole surface of the encapsulation part **140** through a deposition process and, then, the first conductive layer is

patterned through a photolithography process using a first mask and an etching process. Thereby, the first routing layer **156a** of each of the first and second routing lines **156** and **186** and the first pad layer **170a** of each of the touch driving pads **170** and the touch sensing pads **180** are formed on the encapsulation part **140**, as exemplarily shown in FIG. 11A. Here, the first conductive layer is formed to have a monolayer structure or a multilayer structure using metals having high corrosion resistance and high acid resistance, such as Al, Ti, Cu, Mo and MoTi. For example, the first conductive layer has a tri-layer structure, such as Ti/Al/Ti or Mo/Al/Mo.

[0103] Thereafter, a second conductive layer is deposited on the whole surface of the substrate **111** provided with the first routing layer **156a** and the first pad layer **170a** formed thereon through a deposition process and, then, the second conductive layer is patterned through a photolithography process using a second mask and an etching process. Thereby, the second bridges **154b**, the second routing layer **156b** and the second pad layer **170b** are formed, as exemplarily shown in FIG. 11B. Here, the second conductive layer employs a transparent conductive film, such as ITO, IZO, ZnO, IGZO or ITO/Ag/ITO, or a conductive polymer.

[0104] Thereafter, the touch insulating film **168** to expose the second routing layer **156b** and the second pad layer **170b** is formed by depositing an inorganic or organic insulating material on the substrate **111** provided with the second bridges **154b**, the second routing layer **156b** and the second pad layer **170b** formed thereon through a deposition process using a metal mask. Thereafter, the touch contact holes **150** are formed by patterning the touch insulating film **168** through a photolithography process using a third mask and an etching process, as exemplarily shown in FIG. 11C.

[0105] Thereafter, a third conductive layer is deposited on the whole surface of the substrate **111** provided with the touch insulating film **168** having the touch contact holes **150** formed thereon through a deposition process and, then, the third conductive layer is patterned through a photolithography process using a fourth mask and an etching process. Thereby, the first bridges **152b**, the third routing layer **156b** and the third pad layer **170c** are formed on the touch insulating film **168**, as exemplarily shown in FIG. 11D. Here, the third conductive layer employs a transparent conductive film, such as ITO, IZO, ZnO, IGZO or ITO/Ag/ITO, or a conductive polymer.

[0106] Thereafter, an organic insulating material is applied to the whole surface of the substrate **111** provided with the first bridges **152b**, the third routing layer **156b** and the third pad layer **170c** formed thereon and, then, the organic insulating material is patterned through a photolithography process using a fifth mask and an etching process. Thereby, the touch protective film **190** to expose the third pad layer **170c** of each of the touch driving pads **170** and the touch sensing pads **180** is formed, as exemplarily shown in FIG. 11E.

[0107] As described above, in this embodiment of the present invention, the conductive layers on the encapsulation part **140** form a double-layer structure and the routing layers included in the routing lines **156** and **186** form a tri-layer structure. In this case, each of the second and third conductive layers on the encapsulation part **140** is formed simultaneously as one of the first to third routing layers **156a**, **156b** and **156c** which is formed of the same material as the corresponding conductive layer. That is, the second bridges **154b** formed of the second conductive layer are formed simultaneously with the second routing layer **156b**,

and the first bridges **152b** formed of the third conductive layer are formed simultaneously with the third routing layer **156c**.

[0108] FIG. 12 illustrates plan and cross-sectional views of an organic light emitting display having touch sensors in accordance with another embodiment of the present disclosure, and FIGS. 13A to 13C are cross-sectional views illustrating routing lines shown in FIG. 12.

[0109] The organic light emitting display shown in FIG. 12 is the same as the organic light emitting display shown in FIGS. 2 and 3, except that each of first and second routing lines **156** and **186** is formed by sequentially stacking a first routing layer **156a**, i.e., a transparent conductive layer, and a second routing layer **156b**, i.e., an opaque conductive layer, and second bridges **154b** formed of a second opaque conductive layer are stacked on first bridges **152b** formed of a first transparent conductive layer so as to correspond to the stacking sequence of the first and second routing lines **156a** and **156b**. Therefore, a detailed description of elements of the organic light emitting display shown in FIG. 12, which are substantially the same as those of the organic light emitting display shown in FIGS. 2 and 3, will be omitted because it is considered to be unnecessary.

[0110] The first bridges **152b** and first and second touch electrodes **152e** and **154e** are formed of the first transparent conductive layer on an inorganic encapsulation layer **146**.

[0111] The second bridges **154b** are formed of the second opaque conductive layer on a touch insulating film **168** located at a higher position than the encapsulation part **140**. The second bridges **154b** are conductively connected to the second touch electrodes **154e** exposed through touch contact holes **150** formed through the touch insulating film **168**.

[0112] The first transparent routing layer **156a** and the second opaque routing layer **156b** included in each of the first and second routing lines **156** and **186** are stacked so as to correspond to the stacking sequence of the first transparent conductive layer and the second opaque conductive layer forming the touch driving lines **152** and the touch sensing lines **154**. That is, each of the first and second routing lines **156** and **186** is formed by sequentially stacking the first routing layer **156a** formed of the first transparent conductive layer and the second routing layer **156b** formed of the second opaque conductive layer.

[0113] Here, the first routing layer **156a** is formed of the first conductive layer including a transparent conductive film, such as ITO, IZO, ZnO, IGZO or ITO/Ag/ITO, or a conductive polymer. The second routing layer **156b** extends from each of the first and second touch electrodes **152e** and **154e** and is formed of the second opaque conductive layer having a monolayer structure or a multilayer structure using Al, Ti, Cu, Mo and MoTi.

[0114] If etching characteristics (for example, etching gases or etching solutions) of materials of the first and second routing layers **156a** and **156b** are the same, the second routing layer **156b** is formed on the first routing layer **156a** to have the same line width as that of the first routing layer **156a**, as exemplarily shown in FIG. 13A, or is formed on the first routing layer **156a** to have a greater line width than that of the first routing layer **156a**, as exemplarily shown in FIG. 13B. Therefore, etching of the first routing layer **156a** having the same etching characteristics as the second routing layer **156b** by an etching solution or etching gas used in formation of the second routing layer **156b** may be prevented.

[0115] If etching characteristics of materials of the first and second routing layers **156a** and **156b** are different, the second routing layer **156b** is formed on the first routing layer **156a** to have a line width which is the same as or different from that of the first routing layer **156a**. For example, the second routing layer **156b** may be formed on the first routing layer **156a** to have a narrower line width than that of the first routing layer **156a**, as exemplarily shown in FIG. 13C.

[0116] As such, each of the first and second routing lines **156** and **186** is formed to have a multilayer structure and, if a break in any one of a plurality of routing conductive layers included in each of the first and second routing lines **156** and **186** occurs, each of a touch driving pulse and a touch signal is transmitted through the remaining routing conductive layers.

[0117] Each of the touch driving pads **170** and the touch sensing pads **180** is formed to have a double-layer structure in the same manner as the first and second routing lines **156** and **186**. That is, each of the touch driving pads **170** and the touch sensing pads **180** has a double-layer structure acquired by stacking the first and second pad layers **170a** and **170b** using the first and second conductive layers.

[0118] As described above, the organic light emitting display in accordance with this embodiment of the present disclosure includes the first and second routing lines **156** and **186** having a multilayer structure, thus preventing a break of the first and second routing lines **156** and **186**. Further, while a touchscreen is attached to a conventional organic light emitting display by an adhesive, in the organic light emitting display in accordance with the present invention, the touch electrodes **152e** and **154e** are directly stacked on the encapsulation part **140** without a separate attachment process and thus the overall fabrication process may be simplified and manufacturing costs may be reduced.

[0119] FIGS. 14A to 14D are views illustrating a method of fabricating the organic light emitting display shown in FIG. 12.

[0120] First, a first conductive layer is deposited on the whole surface of the encapsulation part **140** through a deposition process and, then, the first conductive layer is patterned through a photolithography process using a first mask and an etching process. Thereby, the first bridges **152b**, the first and second touch electrodes **152e** and **154e**, the first routing layer **156a** and the first pad layer **170a** are formed on the encapsulation part **140**, as exemplarily shown in FIG. 14A. Here, the first conductive layer employs a transparent conductive film, such as ITO, IZO, ZnO, IGZO or ITO/Ag/ITO, or a conductive polymer.

[0121] Thereafter, a touch insulating film **168** to expose the second routing layer **156b** and the second pad layer **170b** is formed by depositing an inorganic or organic insulating material on the substrate **111** provided with the first bridges **152b**, the first and second touch electrodes **152e** and **154e**, the first routing layer **156a** and the first pad layer **170a** formed thereon through a deposition process using a metal mask. Thereafter, touch contact holes **150** are formed by patterning the touch insulating film **168** through a photolithography process using a second mask and an etching process, as exemplarily shown in FIG. 14B.

[0122] Thereafter, a second conductive layer is deposited on the whole surface of the substrate **111** provided with the touch insulating film **168** having the touch contact holes **150** formed thereon through a deposition process and, then, the second conductive layer is patterned through a photolithog-

raphy process using a third mask and an etching process. Thereby, the second bridges **154b**, the second routing layer **156b** and the second pad layer **170b** are formed on the touch insulating film **168**, as exemplarily shown in FIG. **14C**. Here, the second conductive layer is formed to have a monolayer structure or a multilayer structure using metals having high corrosion resistance and high acid resistance, such as Al, Ti, Cu, Mo and MoTi.

[0123] Thereafter, an organic insulating material is applied to the whole surface of the substrate **111** provided with the second bridges **154b**, the second routing layer **156b** and the second pad layer **170b** formed thereon and, then, the organic insulating material is patterned through a photolithography process using a fourth mask and an etching process. Thereby, a touch protective film **190** to expose the second pad layer **170b** of each of the touch driving pads **170** and the touch sensing pads **180** is formed, as exemplarily shown in FIG. **14D**.

[0124] As described above, in this embodiment of the present invention, the first bridges **152b** and the first routing layer **156a** formed of the first conductive layer located at a lower layer are simultaneously formed, and the second bridges **154b** and the second routing layer **156b** formed of the second conductive layer located at an upper layer are simultaneously formed.

[0125] FIG. **15** illustrates plan and cross-sectional views of an organic light emitting display having touch sensors in accordance with yet another embodiment of the present disclosure, and FIGS. **16A** to **16D** are cross-sectional views illustrating routing lines shown in FIG. **15** in accordance with embodiments.

[0126] The organic light emitting display shown in FIG. **15** is the same as the organic light emitting display shown in FIGS. **2** and **3**, except that each of first and second routing lines **156** and **186** is formed by sequentially stacking a first routing layer **156a**, i.e., a transparent conductive layer, a second routing layer **156b**, i.e., an opaque conductive layer, and a third routing layer **156c**, i.e., a transparent conductive layer, and second bridges **154b** formed of a third transparent conductive layer are stacked on first bridges **152b** formed of a first transparent conductive layer so as to correspond to the stacking sequence of the transparent conductive layers of the first and second routing lines **156** and **186**. Therefore, a detailed description of elements of the organic light emitting display shown in FIG. **15**, which are substantially the same as those of the organic light emitting display shown in FIGS. **2** and **3**, will be omitted because it is considered to be unnecessary.

[0127] The first bridges **152b** and the first and second touch electrodes **152e** and **154e** are formed of the first transparent conductive layer on an inorganic encapsulation layer **146**.

[0128] The second bridges **154b** are formed of the third transparent conductive layer on a touch insulating film **168** located at a higher position than the encapsulation part **140**. The second bridges **154b** are exposed through touch contact holes **150** formed through the touch insulating film **168** and conductively connected to the second touch electrodes **154e**.

[0129] Each of the first and second routing lines **156** and **186** is formed by sequentially stacking the first routing layer **156a** formed of the first transparent conductive layer, the second routing layer **156b** formed of the second opaque conductive layer, and the third routing layer **156c** formed of the third transparent conductive layer.

[0130] Here, the first routing layer **156a** extends from each of the first and second touch electrodes **152e** and **154e**, and is formed of the first conductive layer including a transparent conductive film, such as ITO, IZO, ZnO, IGZO or ITO/Ag/ITO, or a conductive polymer. The second routing layer **156b** is formed of the second opaque conductive layer having a monolayer structure or a multilayer structure using Al, Ti, Cu, Mo and MoTi. The third routing layer **156c** is formed of the third conductive layer including a transparent conductive film, such as ITO, IZO, ZnO, IGZO or ITO/Ag/ITO, or a conductive polymer.

[0131] If etching characteristics (for example, etching gases or etching solutions) of materials of the second routing layer **156b** and third routing layers **156c** are the same, the third routing layer **156c** is formed on the second routing layer **156b** to have the same line width as that of the second routing layer **156b**, as exemplarily shown in FIG. **16A**, or the third routing layer **156c** is formed on the second routing layer **156b** to have a greater line width than that of the second routing layer **156b**, as exemplarily shown in FIG. **16B**. If etching characteristics of materials of the first and second routing layers **156a** and **156b** are different, the second routing layer **156b** is formed on the first routing layer **156a** to have a line width which is the same as or different from that of the first routing layer **156a**. For example, the second routing layer **156b** may be formed on the first routing layer **156a** to have a narrower line width than that of the first routing layer **156a**, as exemplarily shown in FIGS. **16C** and **16D**.

[0132] Further, if etching characteristics (for example, etching gases or etching solutions) of materials of the second and third routing layers **156b** and **156c** are the same, the third routing layer **156c** is formed on the second routing layer **156b** to have the same line width as that of the second routing layer **156b**, as exemplarily shown in FIG. **16A**, or is formed on the second routing layer **156b** to have a greater line width than that of the second routing layer **156b**, as exemplarily shown in FIGS. **16B** and **16C**. If etching characteristics of materials of the second and third routing layers **156b** and **156c** are different, the third routing layer **156c** is formed on the second routing layer **156b** to have a line width which is the same as or different from that of the second routing layer **156b**. For example, the third routing layer **156c** may be formed on the second routing layer **156b** to have a narrower line width than that of the second routing layer **156b**.

[0133] As such, each of the first and second routing lines **156** and **186** is formed to have a multilayer structure and, if a break in any one of a plurality of routing conductive layers included in each of the first and second routing lines **156** and **186** occurs, each of a touch driving pulse and a touch signal is transmitted through the remaining routing conductive layers.

[0134] Each of the touch driving pads **170** and the touch sensing pads **180** is formed to have a tri-layer structure in the same manner as the first and second routing lines **156** and **186**. That is, each of the touch driving pads **170** and the touch sensing pads **180** has a tri-layer structure acquired by stacking the first to third pad layers **170a** to **170c** using the first to third conductive layers.

[0135] As described above, the organic light emitting display in accordance with this embodiment of the present disclosure includes the first and second routing lines **156** and **186** having a multilayer structure, thus preventing a break of

the first and second routing lines **156** and **186**. Further, while a touchscreen is attached to a conventional organic light emitting display by an adhesive, in the organic light emitting display in accordance with the present disclosure, the touch electrodes **152e** and **154e** are directly stacked on the encapsulation part **140** without a separate attachment process and thus the overall fabrication process may be simplified and manufacturing costs may be reduced.

[0136] FIGS. 17A to 17E are views illustrating a method of fabricating the organic light emitting display shown in FIG. 15.

[0137] First, a first conductive layer is deposited on the whole surface of the encapsulation part **140** through a deposition process and, then, the first conductive layer is patterned through a photolithography process using a first mask and an etching process. Thereby, the first bridges **152b**, the first and second touch electrodes **152e** and **154e**, the first routing layer **156a** and the first pad layer **170a** are formed on the encapsulation part **140**, as exemplarily shown in FIG. 17A. Here, the first conductive layer employs a transparent conductive film, such as ITO, IZO, ZnO, IGZO or ITO/Ag/ITO, or a conductive polymer.

[0138] Thereafter, a touch insulating film **168** to expose the second routing layer **156b** and the second pad layer **170b** is formed by depositing an inorganic or organic insulating material on the substrate **111** provided with the first bridges **152b**, the first and second touch electrodes **152e** and **154e**, the first routing layer **156a** and the first pad layer **170a** formed thereon through a deposition process using a metal mask. Thereafter, touch contact holes **150** are formed by patterning the touch insulating film **168** through a photolithography process using a second mask and an etching process, as exemplarily shown in FIG. 17B.

[0139] Thereafter, a second conductive layer is deposited on the whole surface of the substrate **111** provided with the touch insulating film **168** having the touch contact holes **150** formed thereon through a deposition process and, then, the second conductive layer is patterned through a photolithography process using a third mask and an etching process. Thereby, the second routing layer **156b** and the second pad layer **170b** are formed on the touch insulating film **168**, as exemplarily shown in FIG. 17C. Here, the second conductive layer is formed to have a monolayer structure or a multilayer structure using metals having high corrosion resistance and high acid resistance, such as Al, Ti, Cu, Mo and MoTi.

[0140] Thereafter, a third conductive layer is deposited on the whole surface of the substrate **111** provided with the second routing layer **156b** and the second pad layer **170b** through a deposition process and, then, the third conductive layer is patterned through a photolithography process using a fourth mask and an etching process. Thereby, the second bridges **154b**, the third routing layer **156c** and the third pad layer **170c** are formed, as exemplarily shown in FIG. 17D. Here, the third conductive layer employs a transparent conductive film, such as ITO, IZO, ZnO, IGZO or ITO/Ag/ITO, or a conductive polymer.

[0141] Thereafter, an organic insulating material is applied to the whole surface of the substrate **111** provided with the second bridges **154b**, the third routing layer **156c** and the third pad layer **170c** formed thereon and, then, the organic insulating material is patterned through a photolithography process using a fifth mask and an etching process. Thereby, a touch protective film **190** to expose the third pad layer

170c of each of the touch driving pads **170** and the touch sensing pads **180** is formed, as exemplarily shown in FIG. 17E.

[0142] As described above, in this embodiment of the present invention, the conductive layers on the encapsulation part **140** form a double-layer structure and the routing layers included in the routing lines **156** and **186** form a tri-layer structure. In this case, each of the first and third conductive layers on the encapsulation part **140** is formed simultaneously as one of the first to third routing layers **156a**, **156b** and **156c** which is formed of the same material as the corresponding conductive layer. That is, the first bridges **152b** formed of the first conductive layer are formed simultaneously with the first routing layer **156a**, and the second bridges **154b** formed of the third conductive layer are formed simultaneously with the third routing layer **156c**.

[0143] An organic light emitting display in accordance with the present disclosure may include a touch buffer film **166** disposed between a first conductive layer forming first bridges **152b** or second bridges **154b** and an encapsulation part **140**, as exemplarily shown in FIG. 18. The touch buffer film **166** is formed between each of touch sensing lines **154** and touch driving lines **152** and a light emitting device **120** and maintains a distance of at least 5 μm between each of the touch sensing lines **154** and the touch driving lines **152** and a cathode **126**. Thereby, parasitic capacitance between each of the touch sensing lines **154** and the touch driving lines **152** and the cathode **126** may be minimized and thus interaction between each of the touch sensing lines **154** and the touch driving lines **152** and the cathode **126** due to coupling therebetween may be prevented.

[0144] Further, although the embodiments exemplarily describe the first and second touch electrodes **152e** and **154e** of the organic light emitting display as being formed of the second conductive layer which is a plate-type transparent conductive layer, the first and second touch electrodes **152e** and **154e** may be formed in a mesh type, as exemplarily shown in FIG. 19. That is, each of the first and second touch electrodes **152e** and **154e** may include a transparent conductive layer **1541** and a mesh metal film **1542** formed in a mesh type on the upper or lower surface of the transparent conductive layer **1541**. Otherwise, each of the first and second touch electrodes **152e** and **154e** may include a mesh metal film **1542** without a transparent conductive layer **1541**, or include a transparent conductive layer **1541** without a mesh metal film **1542**. Here, the mesh metal film **1542** has higher conductivity than the transparent conductive layer **1541** and may thus form low-resistance electrodes as the first and second touch electrodes **152e** and **154e**. Thereby, resistances and capacitances of the touch electrodes **152e** and **154e** are reduced and a time constant RC is reduced, thus improving touch sensitivity. Further, the mesh metal film **1542** has a greatly thin line width and may thus prevent an aperture ratio and transmittance from being lowered due to the mesh metal film **1542**. Further, bridges **154b** disposed on a plane different from the touch electrodes **152e** and **154e** may include a plurality of slits **151**, as exemplarily shown in FIG. 19. Thereby, the bridges **154b** provided with slits **151** may have a reduced area, as compared to bridges provided with no slits. Therefore, reflection of external light by the bridges **154b** may be reduced and thus lowering of visibility may be prevented. The bridges **154b** provided with the slits **151** are formed of a transparent conductive layer or an opaque conductive layer. If the bridges **154b** are formed of

an opaque conductive layer, the bridges **154b** overlap banks, thus preventing lowering of an aperture ratio.

[0145] As apparent from the above description, an organic light emitting display having touch sensors in accordance with the present disclosure includes first and second routing lines having a multilayer structure and, thus, a break of the first and second routing lines may be prevented. Further, in the organic light emitting display in accordance with the present disclosure, touch electrodes are directly disposed within an encapsulation part without an adhesive and thus a separate attachment process is omitted, thereby simplifying the overall fabrication process and reducing manufacturing costs.

[0146] It will be apparent to those skilled in the art that various modifications and variations can be made in the present invention without departing from the spirit or scope of the inventions. Thus, it is intended that the present invention covers the modifications and variations of this invention provided they come within the scope of the appended claims and their equivalents.

What is claimed is:

1. An organic light emitting display comprising:
 - a light emitting device disposed in an active area of a substrate that displays images;
 - an encapsulation part disposed on the light emitting device, the encapsulation part including a plurality of inorganic encapsulation layers and at least one organic encapsulation layer;
 - a plurality of touch sensing lines and a plurality of touch driving lines disposed on the encapsulation part, the plurality of touch sensing lines and the plurality of touch driving lines intersecting each other in the active area, and the plurality of touch driving lines and the plurality of touch sensing lines each including a plurality of conductive layers arranged in a stacking sequence; and
 - a plurality of routing lines connected to the plurality of touch sensing lines and the plurality of touch driving lines, each of the plurality of routing lines including a plurality of routing layers, each of the plurality of routing layers made of a same material as a corresponding one of the plurality of conductive layers and the plurality of routing layers arranged in a same stacking sequence as the stacking sequence of the plurality of conductive layers.
2. The organic light emitting display according to claim 1, wherein at least one of the plurality of touch driving lines includes:
 - a plurality of first touch electrodes disposed in a first direction; and
 - a plurality of first bridges, each first bridge of the plurality of first bridges connecting together a pair of first touch electrodes from the plurality of first touch electrodes, wherein at least one of the plurality of touch sensing lines includes:
 - a plurality of second touch electrodes disposed in a second direction that intersects the first direction; and
 - a plurality of second bridges, each second bridge of the plurality of second bridges connecting together a pair of second touch electrodes from the plurality of second touch electrodes.
3. The organic light emitting display according to claim 2, further comprising:

a plurality of auxiliary bridges, each auxiliary bridge of the plurality of auxiliary bridges disposed under a corresponding one of the plurality of second bridges and each auxiliary bridge of the plurality of auxiliary bridges directly connected to a corresponding first bridge from the plurality of first bridges;

wherein the plurality of auxiliary bridges comprises a first opaque conductive layer composed of a metal;

wherein the plurality of first bridges and each of the plurality of first touch electrodes and the plurality of second touch electrodes comprise a second conductive layer composed of a transparent conductive film and the second conductive layer directly on the first opaque conductive layer; and

wherein the plurality of second bridges are composed of a third transparent conductive film and a portion of each of the plurality of second bridges is over a corresponding one of the plurality of auxiliary bridges, the first touch electrodes, and the second touch electrodes; and

wherein the plurality of routing layers include:

a first routing layer comprising a same material as the first opaque conductive layer;

a second routing layer directly on the first routing layer and comprising a same material as the second conductive layer; and

a third routing layer directly on the second routing layer and comprising a same material as a third conductive layer.

4. The organic light emitting display according to claim 2, wherein:

the plurality of second bridges comprising a first conductive layer comprising an opaque conductive film; and the plurality of first bridges, the plurality of first touch electrodes, and the plurality of second touch electrodes comprise a second conductive layer comprising a transparent conductive film, the second conductive layer is located over the first conductive layer; and

the plurality of routing layers include:

a first routing layer comprising a same material as the first conductive layer; and

a second routing layer directly on the first routing layer and comprising a same material as the second conductive layer.

5. The organic light emitting display according to claim 2, wherein:

the plurality of second bridges comprise a first conductive layer comprising a transparent conductive film; and

the plurality of first bridges, the plurality of first touch electrodes, and the plurality of second touch electrodes comprise a second conductive layer comprising a transparent conductive film; and

the plurality of routing layers include:

a first routing layer disposed on the encapsulation part and comprising an opaque conductive layer;

a second routing layer directly on the first routing layer and comprising a same material as the first conductive layer; and

a third routing layer directly on the second routing layer and comprising a same material as the second conductive layer.

6. The organic light emitting display according to claim 2, wherein:

the plurality of first bridges, the plurality of first touch electrodes, and the plurality of second touch electrodes comprise a first conductive layer formed of a transparent conductive film; and

the plurality of second bridges comprise a second conductive layer formed of an opaque conductive film; and the plurality of routing layers include:

a first routing layer formed of a same material as the first conductive layer; and

a second routing layer directly on the first routing layer and comprising a same material as the second conductive layer.

7. The organic light emitting display according to claim 2, wherein:

the plurality of first bridges, the plurality of first touch electrodes, and the plurality of second touch electrodes comprise a first conductive layer comprising a first transparent conductive film; and

the plurality of second bridges comprising a second conductive layer comprising a second transparent conductive film; and

the routing layers include:

a first routing layer comprising a same material as the first conductive layer;

a second routing layer directly on the first routing layer and comprising an opaque conductive film; and

a third routing layer directly on the second routing layer and formed of a same material as the second conductive layer.

8. The organic light emitting display according to claim 3, further comprising:

a touch buffer film disposed between the encapsulation part and the first opaque conductive layer.

9. The organic light emitting display according to claim 2, wherein at least one of the plurality of first touch electrodes or the plurality of second touch electrodes is formed in a mesh pattern.

10. The organic light emitting display according to claim 2, wherein at least one of the plurality of first bridges or the plurality of second bridges includes at least one slit.

11. The organic light emitting display according to claim 3 wherein:

the first opaque conductive layer has a monolayer structure or a multilayer structure using at least one of aluminum, titanium, copper, molybdenum and molybdenum titanium alloy; and

the transparent conductive film is formed of indium tin oxide ITO, indium zinc oxide IZO, zinc oxide ZnO, indium gallium zinc oxide IGZO, a combination of ITO, Ag, and ITO or a conductive polymer.

12. A method of fabricating an organic light emitting display comprising:

forming a light emitting device disposed in an active area of a substrate that displays images;

forming an encapsulation part including a plurality of inorganic encapsulation layers and at least one organic encapsulation layer on the light emitting device; and

forming a plurality of touch sensing lines, a plurality of touch driving lines, and a plurality of routing lines on the encapsulation part,

wherein the plurality of touch sensing lines and the plurality of touch driving lines intersect each other in the active area, and the plurality of touch driving lines

and the plurality of touch sensing lines each include a plurality of conductive layers arranged in a stacking sequence; and

wherein each of the plurality of routing lines include a plurality of routing layers, each of the plurality of routing layers made of a same material as a corresponding one of the plurality of conductive layers and the plurality of routing layers arranged in a same stacking sequence as the stacking sequence of the plurality of conductive layers.

13. The method according to claim 12, wherein:

a total number of routing layers included in the plurality of routing layers is the same as a total number of conductive layers included in the plurality of touch driving lines and the plurality of touch sensing lines; and

each of the plurality of routing layers is formed simultaneously with a corresponding one of the plurality of conductive layers.

14. The method according to claim 12, wherein:

a total number of routing layers included in the plurality of routing layers is different from a total number of conductive layers included in the plurality of touch driving lines and the plurality of touch sensing lines; and

each of the plurality of routing layers is formed simultaneously with a corresponding one of the plurality of conductive layers that is made of a same material as the routing layer.

15. A display device comprising:

a substrate comprising an active region that displays images and a non-active region that does not display images;

a light emitting device that emits light in the active area of the substrate;

a touch sensor in the active area of the substrate that senses touch of the display device, the touch sensor over the light emitting device and including a plurality of conductive layers, the plurality of conductive layers arranged in a stacking sequence; and

a plurality of routing lines in the non-active region of the substrate that are connected to the touch sensor, each of the plurality of routing lines including a plurality of routing layers, each of the plurality of routing layers made of a same material as a corresponding one of the plurality of conductive layers included in the touch sensor, and the plurality of routing layers arranged in a same stacking sequence as the stacking sequence of the plurality of conductive layers of the touch sensor.

16. The display device of claim 15, wherein the touch sensor includes a touch driving line and a touch sensing line that intersects the touch driving line,

wherein the touch driving line includes:

a plurality of first touch electrodes disposed in a first direction; and

a plurality of first bridges, each first bridge of the plurality of first bridges connecting together a pair of first touch electrodes of the plurality of first touch electrodes;

wherein the touch sensing line includes:

a plurality of second touch electrodes disposed in a second direction that intersects the first direction; and

a plurality of second bridges, each second bridge of the plurality of second bridges connecting together a pair of second touch electrodes of the plurality of second touch electrodes.

17. The display device of claim **16**, further comprising:

a plurality of auxiliary bridges, each auxiliary bridge of the plurality of auxiliary bridges disposed under a corresponding one of the plurality of second bridges and each auxiliary bridge of the plurality of auxiliary bridges directly connected to a corresponding first bridge of the plurality of first bridges; and

wherein the plurality of routing layers include:

a first routing layer comprising a same material as the plurality of auxiliary bridges;

a second routing layer directly on the first routing layer and comprising a same material as the plurality of first bridges, the plurality of first touch electrodes, and the plurality of second touch electrodes; and

a third routing layer directly on the second routing layer and comprising a same material as the plurality of second bridges.

18. The display device of claim **16**, wherein:

the plurality of first bridges, the plurality of first touch electrodes, and the plurality of second touch electrodes are in a same plane that is over the plurality of second bridges; and

the plurality of routing layers include:

a first routing layer comprising a same material as the plurality of second bridges; and

a second routing layer directly on the first routing layer and comprising a same material as the plurality of first bridges, the plurality of first touch electrodes, and the plurality of second touch electrodes.

19. The display device of claim **16**, wherein:

the plurality of first bridges, the plurality of first touch electrodes, and the plurality of second touch electrodes are in a same plane that is over the plurality of second bridges; and

the plurality of routing layers include:

a first routing layer; and

a second routing layer directly on the first routing layer and comprising a same material as the plurality of second bridges;

a third routing layer directly on the second routing layer and comprising a same material as the plurality of first bridges, the plurality of first touch electrodes, and the plurality of second touch electrodes;

wherein the first routing layer is made of a material that is different from the second routing layer and the third routing layer.

20. The display device of claim **16**, wherein:

the plurality of first bridges, the plurality of first touch electrodes, and the plurality of second touch electrodes are in a same plane that is under the plurality of second bridges; and

the plurality of routing layers include:

a first routing layer comprising a same material as the plurality of first bridges, the plurality of first touch electrodes, and the plurality of second touch electrodes; and

a second routing layer directly on the first routing layer and comprising a same material as the plurality of second bridges.

21. The display device of claim **16**, wherein:

the plurality of first bridges, the plurality of first touch electrodes, and the plurality of second touch electrodes are in a same plane that is under the plurality of second bridges; and

the plurality of routing layers include:

a first routing layer comprising a same material as the plurality of first bridges, the plurality of first touch electrodes, and the plurality of second touch electrodes; and

a second routing layer directly on the first routing layer; and

a third routing layer directly on the second routing layer and comprising a same material as the plurality of second bridges;

wherein the second routing layer is made of a material that is different from the first routing layer and the third routing layer.

* * * * *

专利名称(译)	具有触摸传感器的有机发光显示器及其制造方法和显示装置		
公开(公告)号	US20180061897A1	公开(公告)日	2018-03-01
申请号	US15/436505	申请日	2017-02-17
[标]申请(专利权)人(译)	乐金显示有限公司		
申请(专利权)人(译)	LG DISPLAY CO. , LTD.		
当前申请(专利权)人(译)	LG DISPLAY CO. , LTD.		
[标]发明人	OH JAE YOUNG KIM MIN JOO LEE JAE WON LEE EUN HYE		
发明人	OH, JAE-YOUNG KIM, MIN-JOO LEE, JAE-WON LEE, EUN-HYE		
IPC分类号	H01L27/32		
CPC分类号	H01L27/323 H01L2227/323 H01L27/3279 G06F3/0412 G06F3/0416 G06F2203/04103 H01L51/56 G06F3/0443 G06F3/0446 G06F2203/04112 G06F3/044 G06F2203/04111 H01L27/3276 H01L51/5256 H01L2251/301 H01L2251/308 H01L27/3246 H01L51/5253		
优先权	1020160112192 2016-08-31 KR		
其他公开文献	US10109686		
外部链接	Espacenet USPTO		

摘要(译)

公开了一种显示装置，包括：衬底，包括有源区和非有源区;发光器件，其在衬底的有源区域中发光;触摸传感器，位于基板的有源区域中，用于感测显示装置的触摸，触摸传感器包括以堆叠顺序布置的多个导电层;连接到触摸传感器的基板的非有源区域中的多条布线线路，多条布线线路中的每条布线线路包括多个布线层，多个布线层中的每一个由与布料层相同的材料制成。包括在触摸传感器中的多个导电层中的相应一个，并且多个路由层以与触摸传感器的多个导电层的堆叠顺序相同的堆叠顺序布置。

